

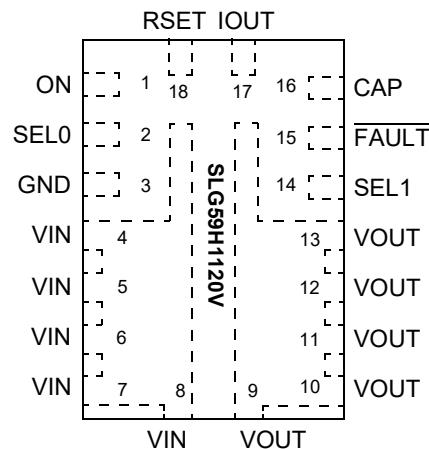
General Description

The SLG59H1120V is a high-performance, self-powered 18 mΩ NMOS load switch designed for all 4.5 V to 12 V power rails up to 5 A. Using a proprietary MOSFET design, the SLG59H1120V achieves a stable 18 mΩ $R_{DS\text{ON}}$ across a wide input voltage range. In combining novel FET design and copper pillar interconnects, the SLG59H1120V package also exhibits a low thermal resistance for high-current operation.

Designed to operate over a -40 °C to 85 °C range, the SLG59H1120V is available in a low thermal resistance, RoHS-compliant, 1.6 x 3.0 mm STQFN package.

Features

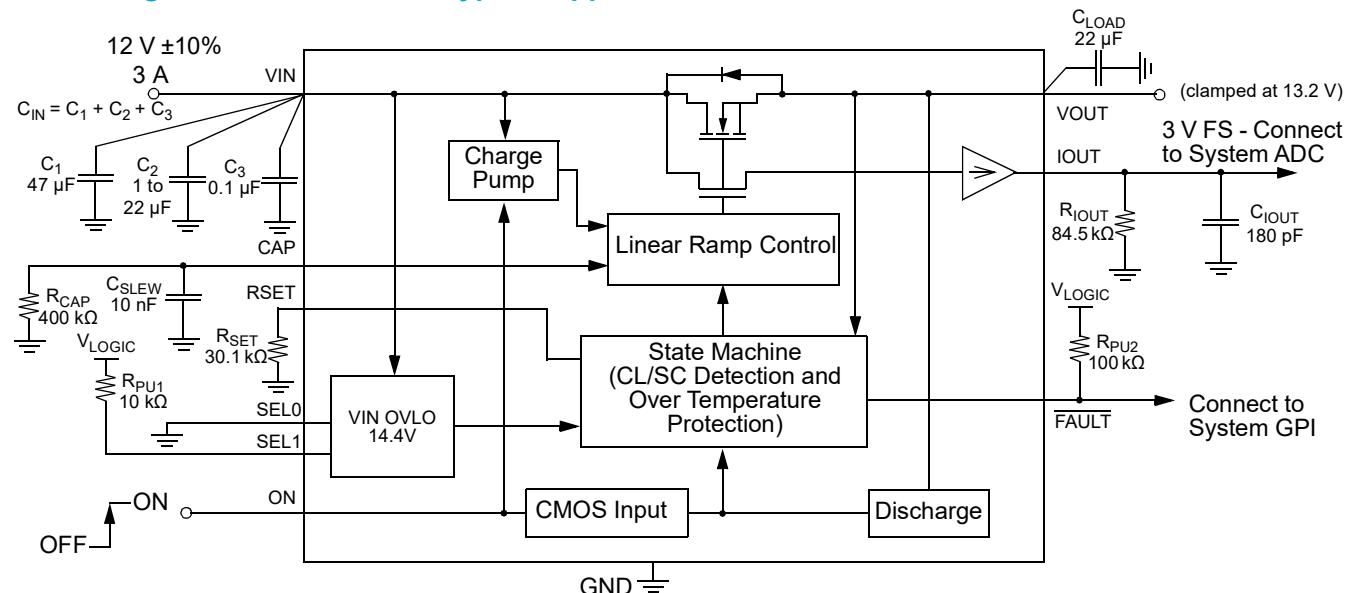
- Wide Operating Input Voltage: 4.5 V to 13.2 V
- Maximum Continuous Current: 5 A
- Automatic nFET SOA Protection
 - 5 W SOA Protection Threshold
- High-performance MOSFET Switch
 - Low $R_{DS\text{ON}}$: 18 mΩ at $V_{IN} = 12$ V
 - Low $\Delta R_{DS\text{ON}}/\Delta V_{IN}$: < 0.05 mΩ/V
 - Low $\Delta R_{DS\text{ON}}/\Delta T$: < 0.06 mΩ/°C
- 3-Level, Pin-selectable V_{IN} Overvoltage Lockout
- Capacitor-adjustable Inrush Current Control
- Two stage Current Limit Protection:
 - Resistor-adjustable Active Current Limit
 - Internal Short-circuit Current limit
- Open Drain FAULT Signaling
- MOSFET Current Analog Output Monitor: 10 $\mu\text{A}/\text{A}$
- Fast 4 kΩ Output Discharge
 - Pb-Free / Halogen-Free / RoHS Compliant Packaging

Pin Configuration**18-pin STQFN**

1.6 x 3.0 mm, 0.40mm pitch
(Top View)

Applications

- Enterprise Computing & Telecom Equipment
5 V and 12 V Point-of-Load Power Distribution
- PCI/PCIe Adapter Cards
- General-purpose High-voltage, Power-Rail Switching
- Multifunction Printers
- Fan Motor Control

Block Diagram and a 12 V / 3 A Typical Application Circuit

Pin Description

| Pin # | Pin Name | Type | Pin Description |
|-------|----------|--------|---|
| 1 | ON | Input | A low-to-high transition on this pin initiates the operation of the SLG59H1120V's state machine. ON is an asserted HIGH, level-sensitive CMOS input with ON_V _{IL} < 0.3 V and ON_V _{IH} > 0.9 V. As the ON pin input circuit does not have an internal pull-down resistor, connect this pin to a general-purpose output (GPO) of a microcontroller, an application processor, or a system controller – do not allow this pin to be open-circuited. |
| 2 | SEL0 | Input | As level-sensitive, CMOS inputs with V _{IL} < 0.3 V and V _{IH} > 1.65 V, the SEL0 (LSB) and the SEL1 (MSB) pins select one of three V _{IN} overvoltage lockout thresholds. Please see the Applications Section for additional information and the Electrical Characteristics table for the V _{IN} overvoltage thresholds. A logic LOW on either pin is achieved by connecting the pin of interest to GND; a logic HIGH on either pin is achieved by connecting a 10 kΩ external resistor from the pin in question to the system's local logic supply. |
| 3 | GND | GND | Pin 3 is the main ground connection for the SLG59H1120V's internal charge pump, its gate driver and current-limit circuits as well as its internal state machine. Therefore, use a short, stout connection from Pin 3 to the system's analog or power plane. |
| 4-8 | VIN | MOSFET | VIN supplies the power for the operation of the SLG59H1120V, its internal control circuitry, and the drain terminal of the nFET load switch. With 5 pins fused together at VIN, connect a 47 μF (or larger) low-ESR capacitor from this pin to ground. Capacitors used at VIN should be rated at 50 V or higher. |
| 9-13 | VOUT | MOSFET | Source terminal of n-channel MOSFET (5 pins fused for VOUT). Connect a 22 μF (or larger) low-ESR capacitor from this pin to ground. Capacitors used at VOUT should be rated at 50 V or higher. |
| 14 | SEL1 | Input | Please see SEL0 Pin Description above |
| 15 | FAULT | Output | An open drain output, FAULT is asserted within TFAULT _{LOW} when a V _{IN} overvoltage, a current-limit, or an over-temperature condition is detected. FAULT is deasserted within TFAULT _{HIGH} when the fault condition is removed. Connect an 100 kΩ external resistor from the FAULT pin to local system logic supply. |
| 16 | CAP | Output | A low-ESR, stable dielectric, ceramic surface-mount capacitor connected from CAP pin to GND sets the V _{OUT} slew rate and overall turn-on time of the SLG59H1120V. For best performance, the range for C _{SLEW} values are 10 nF ≤ C _{SLEW} ≤ 20 nF – please see typical characteristics for additional information. Capacitors used at the CAP pin should be rated at 10 V or higher. Please consult Applications Section on how to select C _{SLEW} based on V _{OUT} slew rate and loading conditions. |
| 17 | IOUT | Output | IOUT is the SLG59H1120V's power MOSFET load current monitor output. As an analog current output, this signal when applied to a ground-reference resistor generates a voltage proportional to the current through the n-channel MOSFET. The I _{OUT} transfer characteristic is typically 10 μA/A with a voltage compliance range of 0.5 V ≤ V _{IOUT} ≤ 4 V. Optimal I _{OUT} linearity is exhibited for 0.5 A ≤ I _{DS} ≤ 5 A. In addition, it is recommended to bypass the IOUT pin to GND with a 0.18 nF capacitor. |
| 18 | RSET | Input | A 1%-tolerance, metal-film resistor between 18 kΩ and 91 kΩ sets the SLG59H1120V's active current limit. A 91 kΩ resistor sets the SLG59H1120V's active current limit to 1 A and a 18 kΩ resistor sets the active current limit to 5 A. |

SLG59H1120V

A 12 V, 18 mΩ, 5 A Load Switch
with V_{IN} Lockout Select and MOSFET Current Monitor Output

Ordering Information

| Part Number | Type | Production Flow |
|---------------|------------------------------|-----------------------------|
| SLG59H1120V | STQFN 18L FC | Industrial, -40 °C to 85 °C |
| SLG59H1120VTR | STQFN 18L FC (Tape and Reel) | Industrial, -40 °C to 85 °C |

A 12 V, 18 mΩ, 5 A Load Switch
with V_{IN} Lockout Select and MOSFET Current Monitor Output

Absolute Maximum Ratings

| Parameter | Description | Conditions | Min. | Typ. | Max. | Unit |
|--|--|--|------|------|----------|------|
| V_{IN} to GND | Load Switch Input Voltage to GND | Continuous | -0.3 | -- | 30 | V |
| | | Maximum pulsed V_{IN} , pulse width < 0.1 s | -- | -- | 32 | V |
| V_{OUT} to GND | Load Switch Output Voltage to GND | | -0.3 | -- | V_{IN} | V |
| ON, SEL[1,0], CAP, RSET, IOUT, and FAULT to GND | ON, SEL[1,0], CAP, RSET, IOUT, and FAULT Pin Voltages to GND | | -0.3 | -- | 7 | V |
| T_S | Storage Temperature | | -65 | -- | 150 | °C |
| ESD _{HBM} | ESD Protection | Human Body Model | 2000 | -- | -- | V |
| ESD _{CDM} | ESD Protection | Charged Device Model | 500 | -- | -- | V |
| MSL | Moisture Sensitivity Level | | 1 | | | |
| θ_{JA} | Thermal Resistance | 1.6 x 3.0 mm 18L STQFN; Determined with the device mounted onto a 1 in ² , 1 oz. copper pad of FR-4 material | -- | 40 | -- | °C/W |
| MOSFET IDS_{CONT} | Continuous Current from V_{IN} to V_{OUT} | $T_J < 150$ °C | -- | -- | 5 | A |
| MOSFET IDS_{PEAK} | Peak Current from V_{IN} to V_{OUT} | Maximum pulsed switch current, pulse width < 1 ms | -- | -- | 6 | A |
| Note: Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability. | | | | | | |

Electrical Characteristics

4.5 V ≤ V_{IN} ≤ 13.2 V; $C_{IN} = 47$ µF, $T_A = -40$ °C to 85 °C, unless otherwise noted. Typical values are at $T_A = 25$ °C

| Parameter | Description | Conditions | Min. | Typ. | Max. | Unit |
|----------------|---|--|------|------|------|------|
| V_{IN} | Operating Input Voltage | | 4.5 | -- | 13.2 | V |
| $V_{IN(OVLO)}$ | V_{IN} Overvoltage Lockout Threshold | $V_{IN} \uparrow$; SEL[1,0] = [0,0] | 5.6 | 6 | 6.3 | V |
| | | $V_{IN} \uparrow$; SEL[1,0] = [0,1] | 10.2 | 10.8 | 11.4 | V |
| | | $V_{IN} \uparrow$; SEL[1,0] = [1,0] | 13.5 | 14.4 | 15.2 | V |
| $V_{IN(UVLO)}$ | V_{IN} Undervoltage Lockout Threshold | $V_{IN} \downarrow$ | 2.4 | -- | 3.8 | V |
| I_Q | Quiescent Supply Current | ON = HIGH; $I_{DS} = 0$ A | -- | 0.5 | 0.6 | mA |
| I_{SHDN} | OFF Mode Supply Current | ON = LOW; $I_{DS} = 0$ A | -- | 1 | 3 | µA |
| $R_{DS_{ON}}$ | ON Resistance | $T_A = 25$ °C; $I_{DS} = 0.1$ A | -- | 18 | 20 | mΩ |
| | | $T_A = 85$ °C; $I_{DS} = 0.1$ A | -- | 22 | 24 | mΩ |
| MOSFET IDS | Current from V_{IN} to V_{OUT} | Continuous | -- | -- | 5 | A |
| I_{LIMIT} | Active Current Limit, I_{ACL} | $V_{OUT} > 0.5$ V; $R_{SET} = 30.1$ kΩ | 2.8 | 3.2 | 3.6 | A |
| | Short-circuit Current Limit, I_{SCL} | $V_{OUT} < 0.5$ V | -- | 0.5 | -- | A |
| T_{ACL} | Active Current Limit Response Time | | -- | 120 | -- | µs |
| $R_{DISCHRG}$ | Output Discharge Resistance | | 3.5 | 4.4 | 5.3 | kΩ |
| I_{OUT} | MOSFET Current Analog Monitor Output | $I_{DS} = 1$ A | 9.3 | 10 | 10.7 | µA |
| | | $I_{DS} = 3$ A | 28.5 | 30 | 31.5 | µA |

A 12 V, 18 mΩ, 5 A Load Switch
with V_{IN} Lockout Select and MOSFET Current Monitor Output

Electrical Characteristics (continued)

4.5 V ≤ V_{IN} ≤ 13.2 V; C_{IN} = 47 μF, T_A = -40 °C to 85 °C, unless otherwise noted. Typical values are at T_A = 25 °C

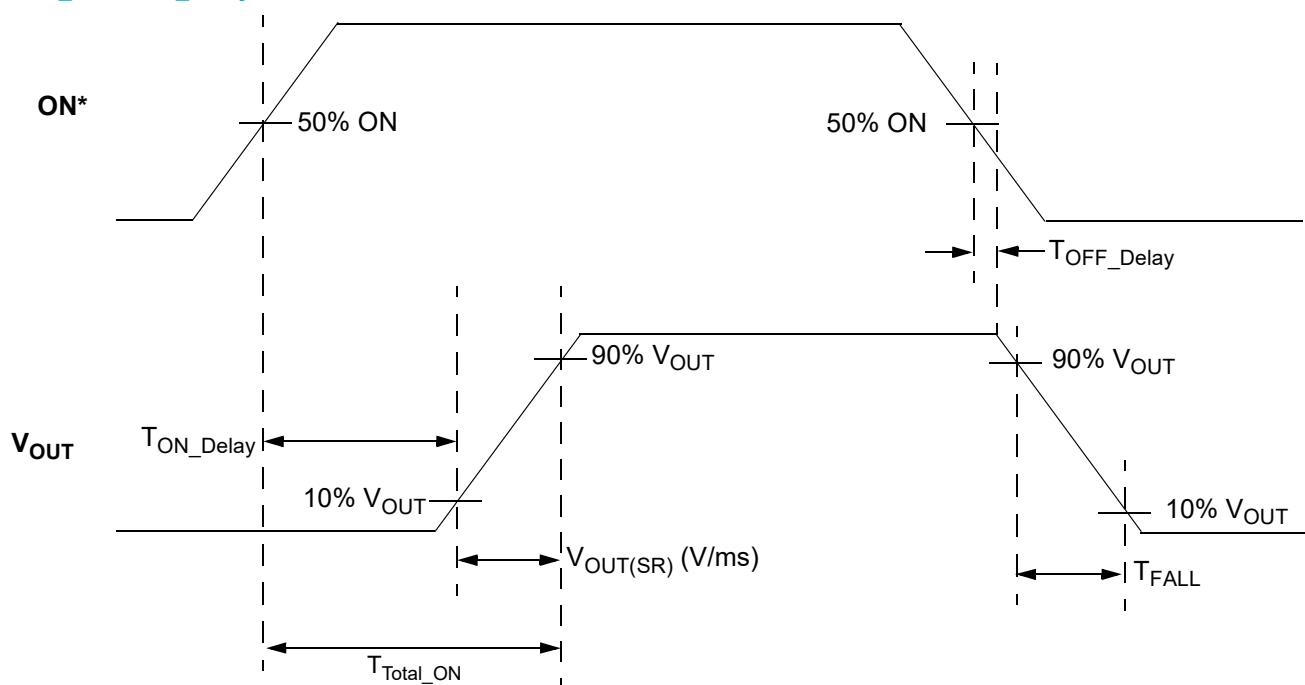
| Parameter | Description | Conditions | Min. | Typ. | Max. | Unit |
|--------------------------|---|--|--|------|------|------|
| T _{IOUT} | I _{OUT} Response Time to Change in Main MOSFET Current | C _{IOUT} = 180 pF; Step load 0 to 2.4 A; 0% to 90% I _{OUT} | -- | 45 | -- | μs |
| C _{LOAD} | Output Load Capacitance | C _{LOAD} connected from V _{OUT} to GND | -- | 22 | -- | μF |
| T _{ON_Delay} | ON Delay Time | 50% ON to 10% V _{OUT} ↑; V _{IN} = 4.5 V; C _{SLEW} = 10 nF; R _{LOAD} = 100 Ω, C _{LOAD} = 10 μF | -- | 0.3 | 0.5 | ms |
| | | 50% ON to 10% V _{OUT} ↑; V _{IN} = 12 V; C _{SLEW} = 10 nF; R _{LOAD} = 100 Ω, C _{LOAD} = 10 μF | -- | 0.7 | 1.2 | ms |
| T _{Total_ON} | Total Turn On Time | 50% ON to 90% V _{OUT} ↑ | Set by External C _{SLEW} ¹ | | | ms |
| | | 50% ON to 90% V _{OUT} ↑; V _{IN} = 4.5 V; C _{SLEW} = 10 nF; R _{LOAD} = 100 Ω, C _{LOAD} = 10 μF | -- | 1.4 | 2.1 | ms |
| | | 50% ON to 90% V _{OUT} ↑; V _{IN} = 12 V; C _{SLEW} = 10 nF; R _{LOAD} = 100 Ω, C _{LOAD} = 10 μF | -- | 5 | 8 | ms |
| V _{OUT(SR)} | V _{OUT} Slew Rate | 10% V _{OUT} to 90% V _{OUT} ↑ | Set by External C _{SLEW} ¹ | | | V/ms |
| | | 10% V _{OUT} to 90% V _{OUT} ↑; V _{IN} = 4.5 V to 12 V; C _{SLEW} = 10 nF; R _{LOAD} = 100 Ω, C _{LOAD} = 10 μF | 2.7 | 3.2 | 3.9 | V/ms |
| T _{OFF_Delay} | OFF Delay Time | 50% ON to V _{OUT} Fall Start ↓; V _{IN} = 4.5 V to 12 V R _{LOAD} = 100 Ω, No C _{LOAD} | -- | 15 | -- | μs |
| T _{FALL} | V _{OUT} Fall Time | 90% V _{OUT} to 10% V _{OUT} ; ON = HIGH-to-LOW; V _{IN} = 4.5 V to 12 V; R _{LOAD} = 100 Ω, No C _{LOAD} | 10.4 | 12.7 | 14.3 | μs |
| T _{FAULT_LOW} | FAULT Assertion Time | Abnormal Step Load Current event to FAULT↓; I _{ACL} = 1 A; V _{IN} = 12 V; R _{SET} = 91 kΩ; switch in 10 Ω load | -- | 80 | -- | μs |
| T _{FAULT_HIGH} | FAULT De-assertion Time | Delay to FAULT↑ after fault condition is removed; I _{ACL} = 1 A; V _{IN} = 12 V; R _{SET} = 91 kΩ; switch out 10 Ω load | -- | 180 | -- | μs |
| FAULT _{VOL} | FAULT Output Low Voltage | I _{FAULT} = 1 mA | -- | 0.2 | -- | V |
| ON_V _{IH} | ON Pin Input High Voltage | | 0.9 | -- | 5 | V |
| ON_V _{IL} | ON Pin Input Low Voltage | | -0.3 | 0 | 0.3 | V |
| SEL[1,0]_V _{IH} | SEL[1,0] pins Input High Voltage | | 1.65 | -- | 4.5 | V |
| SEL[1,0]_V _{IL} | SEL[1,0] pins Input Low Voltage | | -0.3 | -- | 0.3 | V |
| I _{ON(Leakage)} | ON Pin Leakage Current | 1 V ≤ ON ≤ 5 V or ON = GND | -- | -- | 1 | μA |
| THERM _{ON} | Thermal Protection Shutdown Threshold | | -- | 125 | -- | °C |
| THERM _{OFF} | Thermal Protection Restart Threshold | | -- | 100 | -- | °C |

Notes:

1. Refer to typical Timing Parameter vs. C_{SLEW} performance charts for additional information when available.

A 12 V, 18 mΩ, 5 A Load Switch
with V_{IN} Lockout Select and MOSFET Current Monitor Output

T_{Total_ON}, T_{ON_Delay} and Slew Rate Measurement

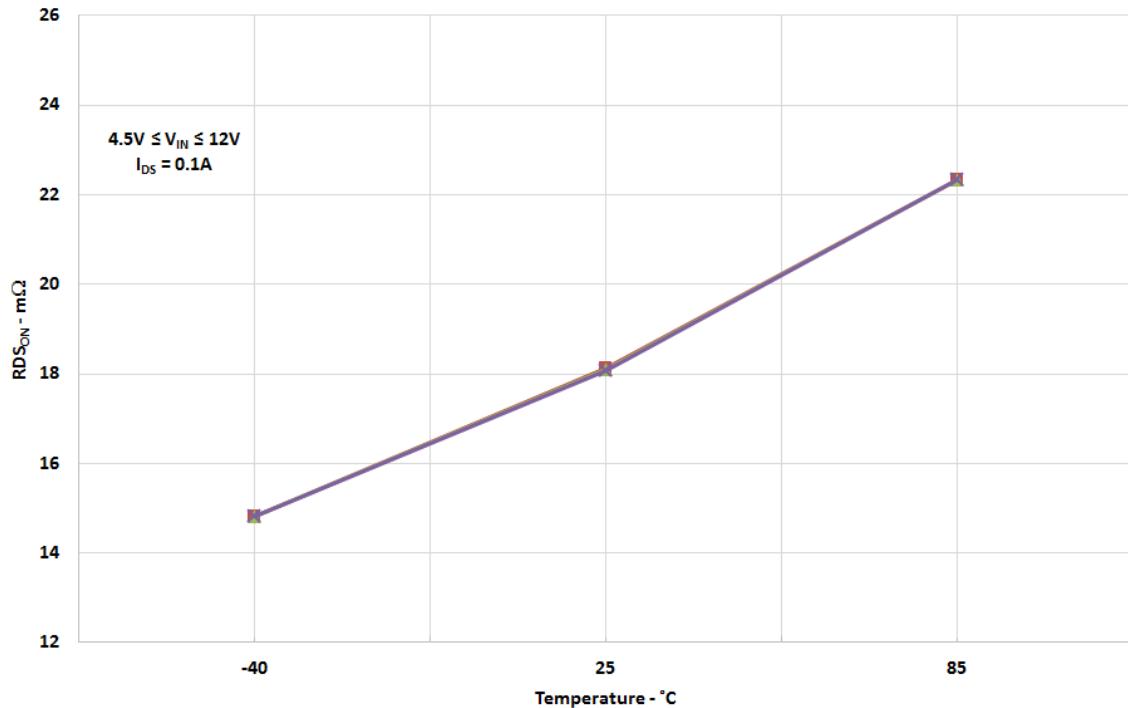
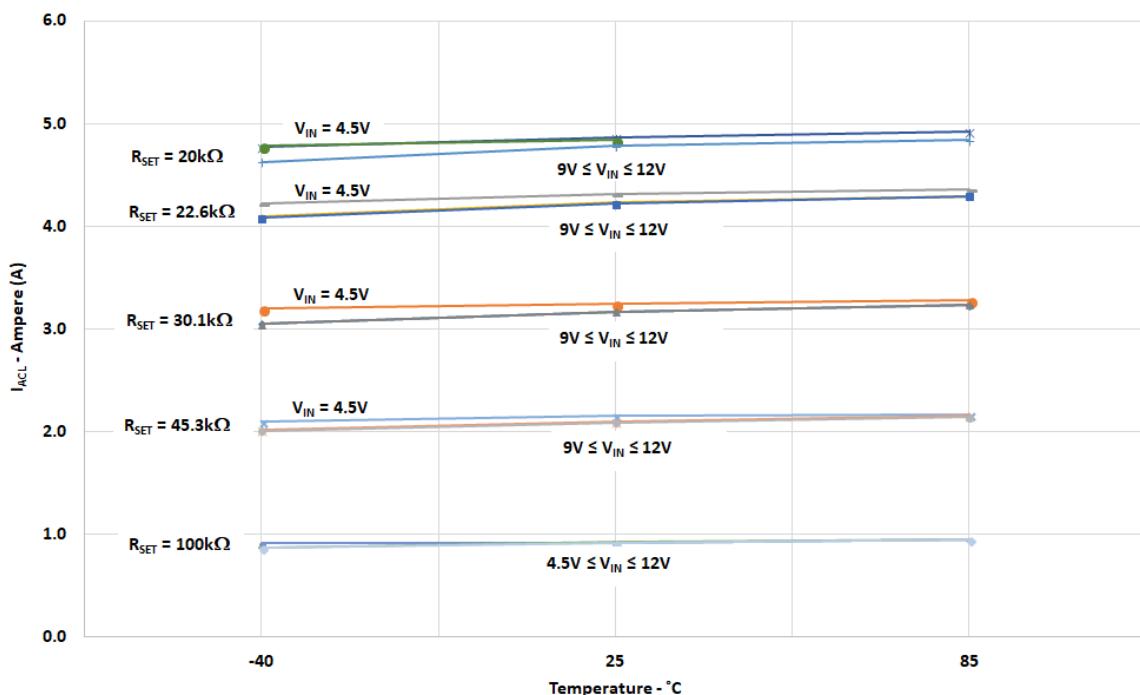


*Rise and Fall Times of the ON Signal are 100 ns

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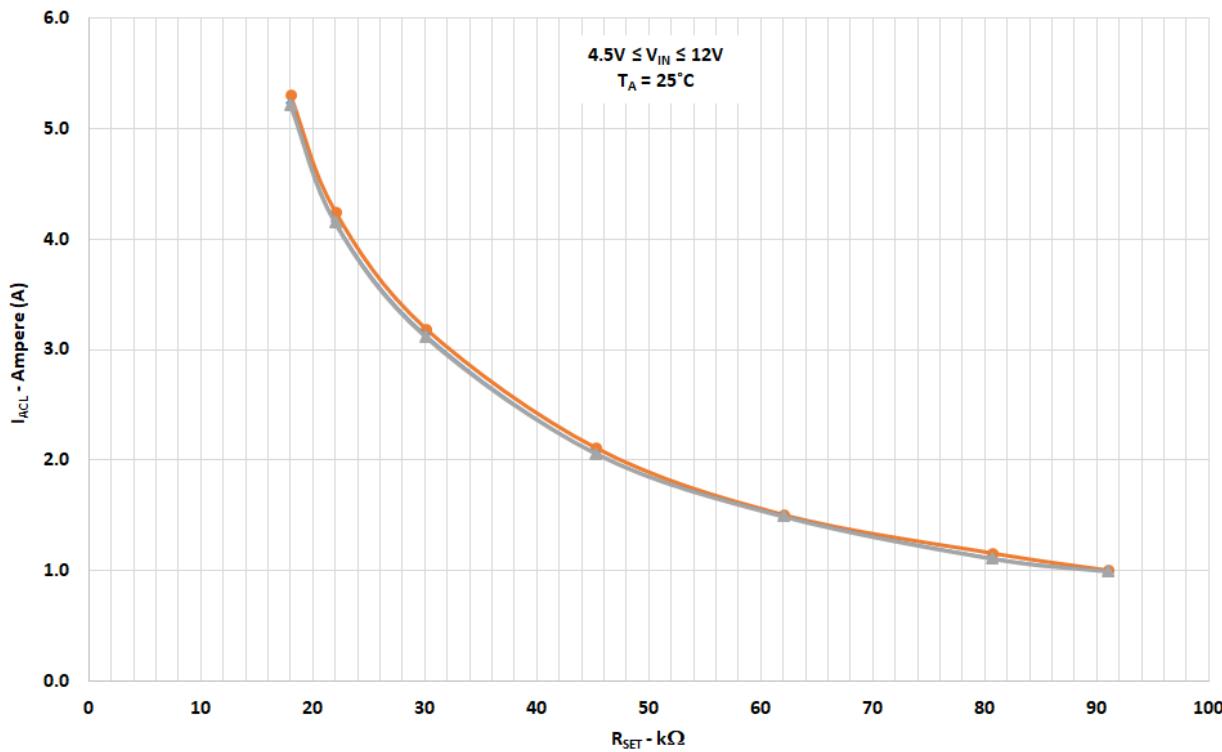
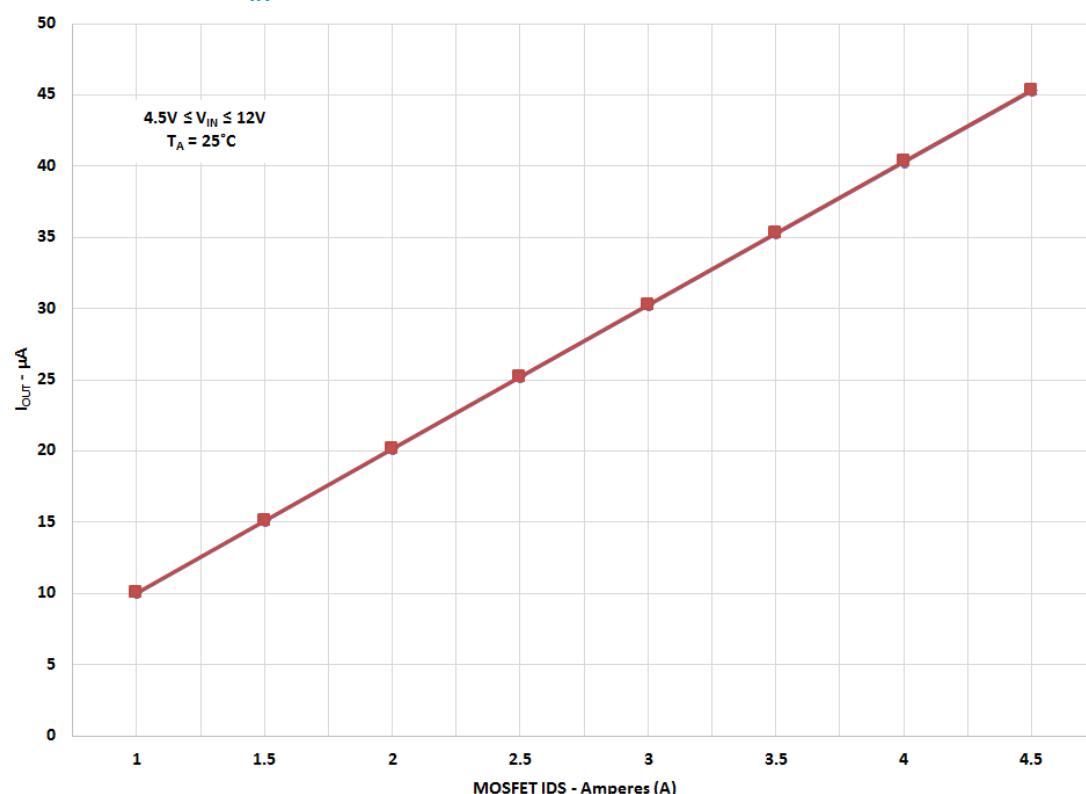
A 12 V, 18 mΩ, 5 A Load Switch
with V_{IN} Lockout Select and MOSFET Current Monitor Output

Typical Performance Characteristics

RDS_{ON} vs. Temperature, and V_{IN}I_{ACL} vs. Temperature and R_{SET}

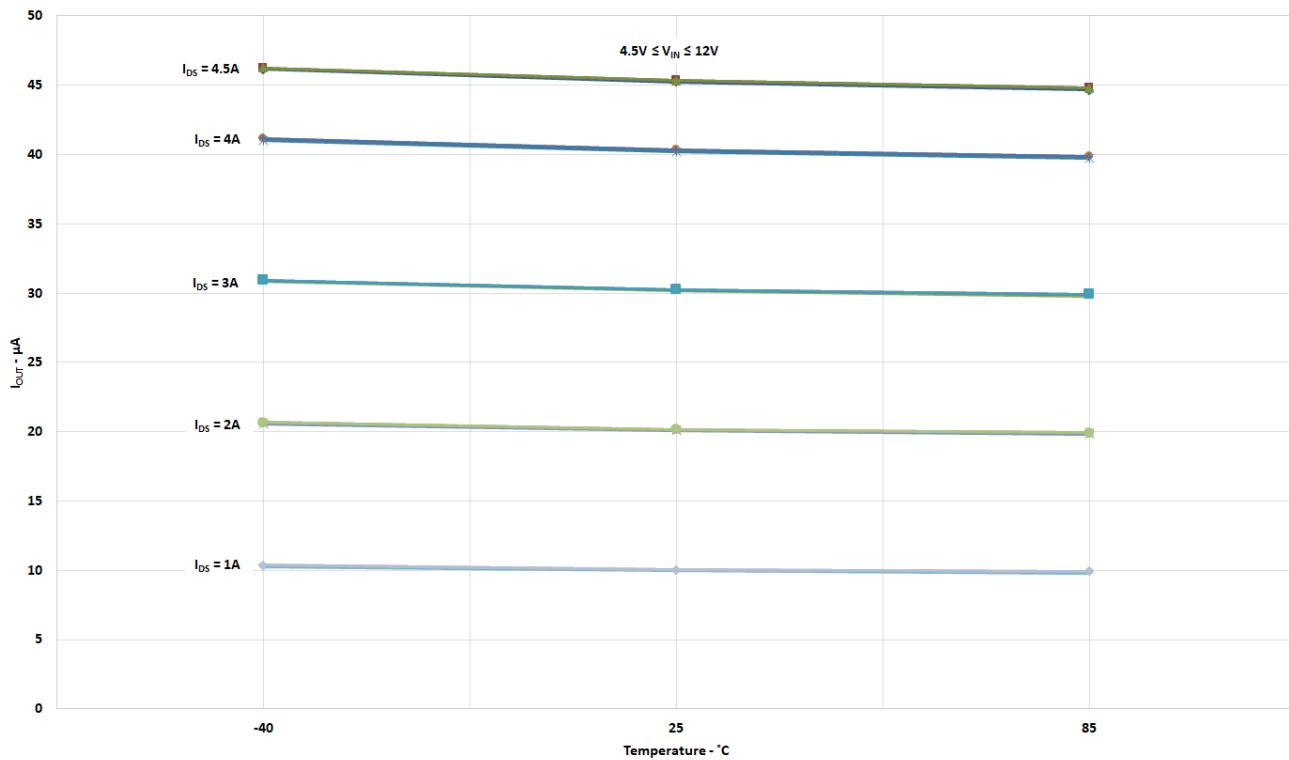
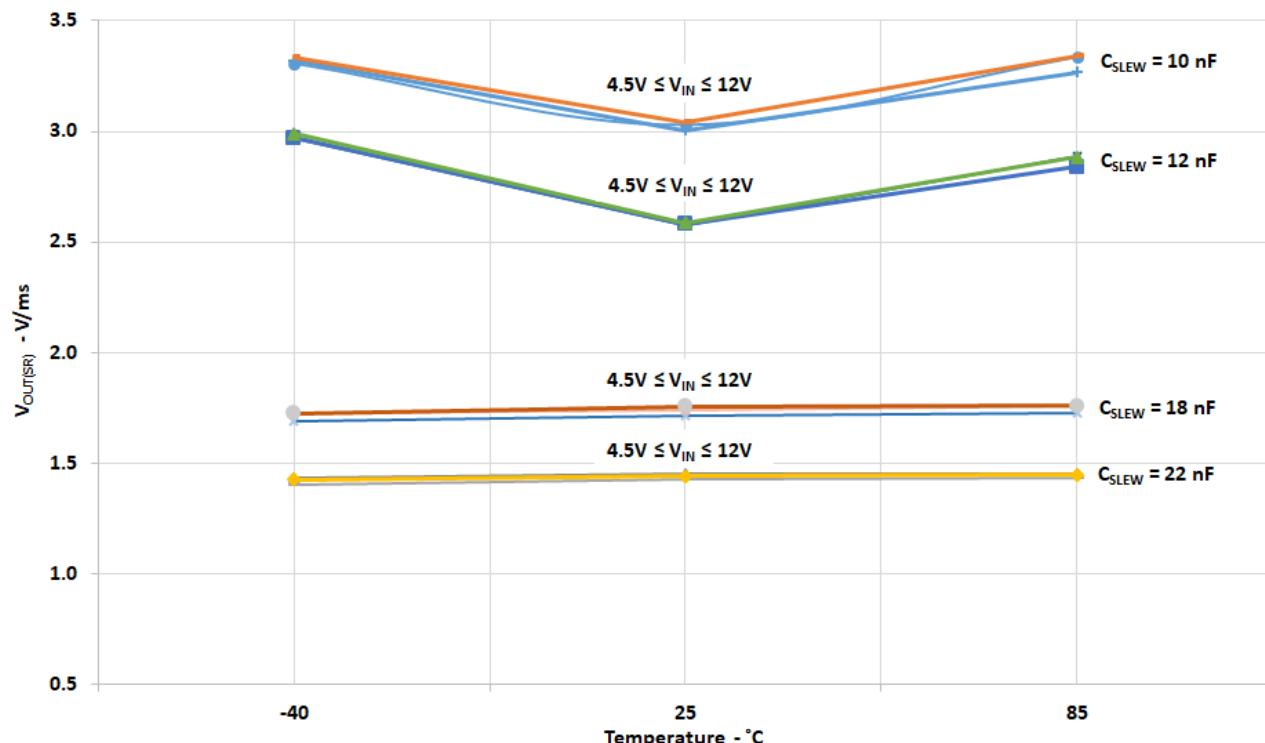
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A 12 V, 18 mΩ, 5 A Load Switch
with V_{IN} Lockout Select and MOSFET Current Monitor Output

 I_{ACL} vs. R_{SET} and V_{IN}  I_{OUT} vs. MOSFET IDS and V_{IN} 

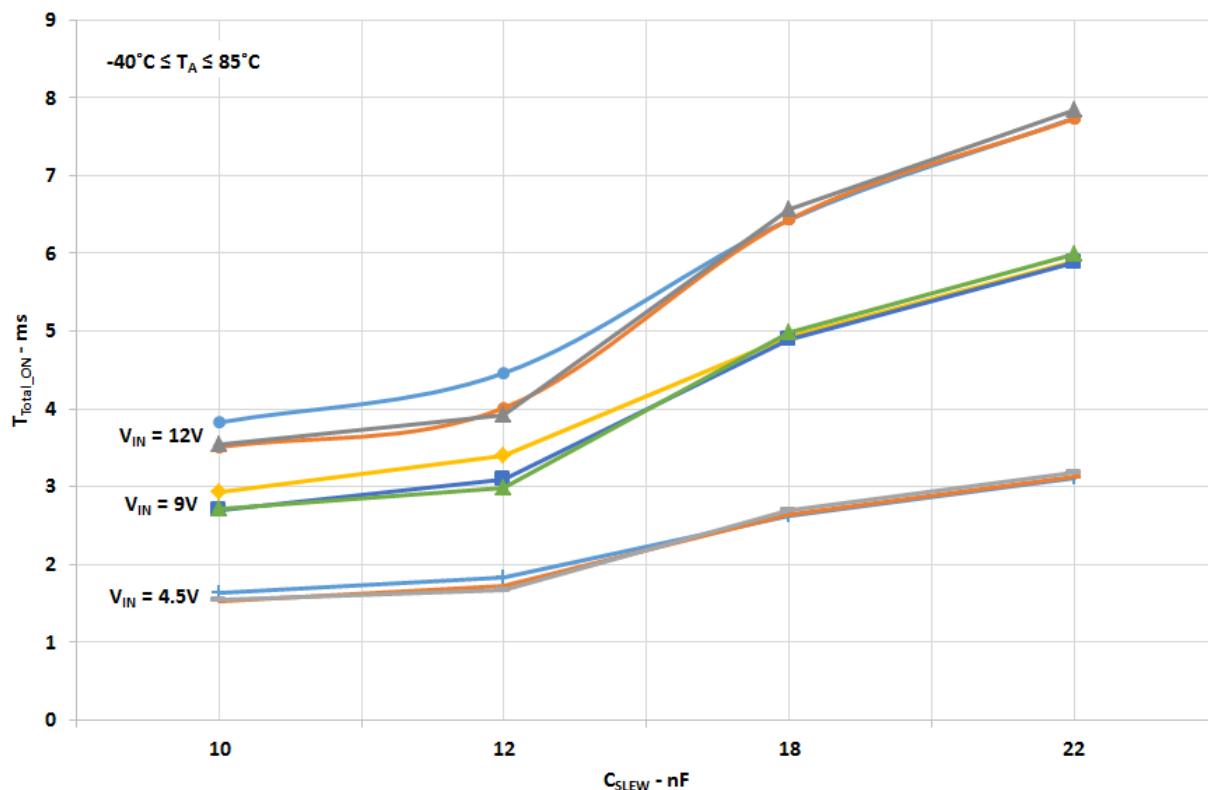
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A 12 V, 18 mΩ, 5 A Load Switch
with V_{IN} Lockout Select and MOSFET Current Monitor Output

I_{OUT} vs. Temperature and MOSFET IDSV_{OUT} Slew Rate vs. Temperature, V_{IN}, and C_{SLEW}

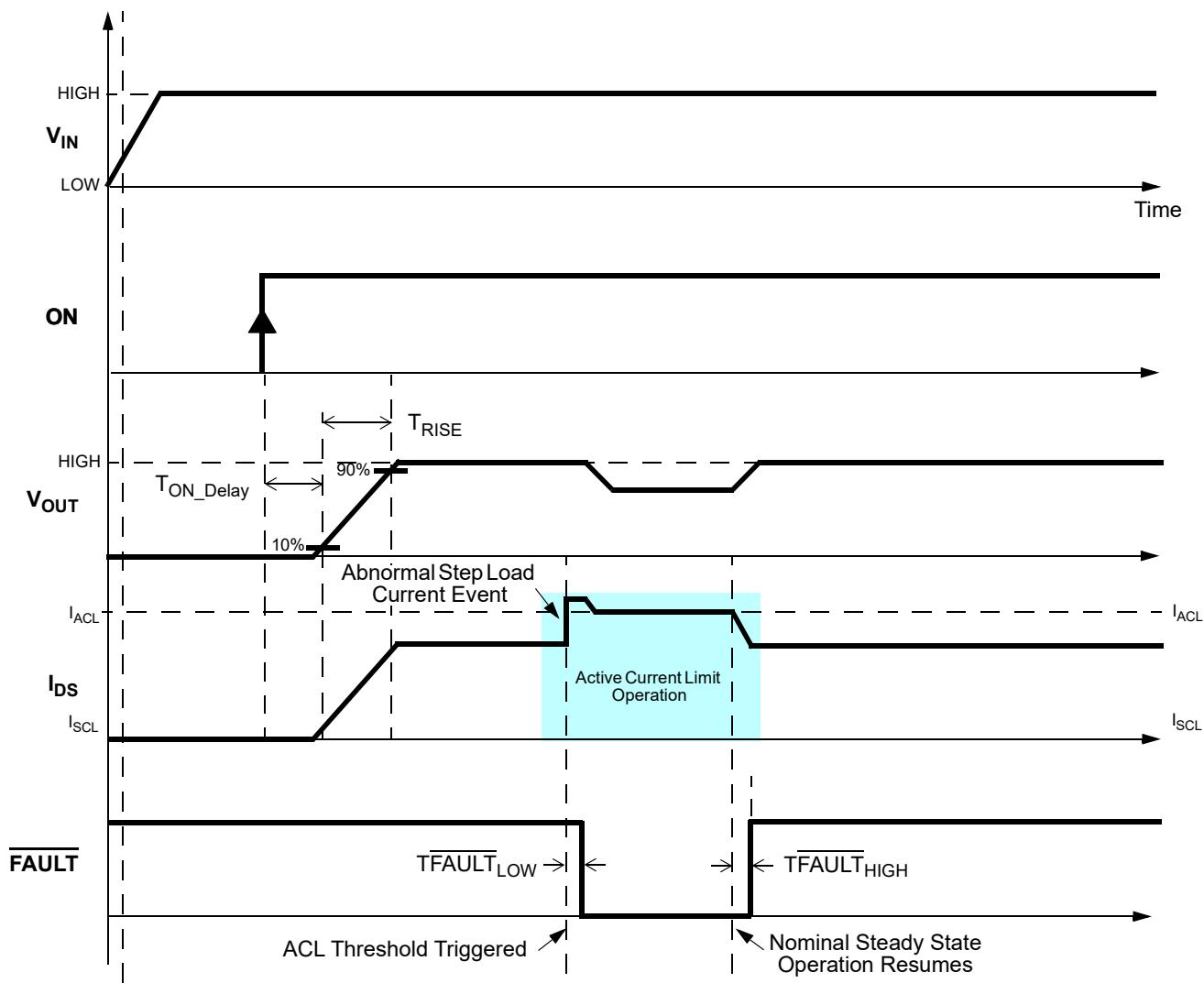
A 12 V, 18 mΩ, 5 A Load Switch
with V_{IN} Lockout Select and MOSFET Current Monitor Output

T_{Total_ON} vs. C_{SLEW} , V_{IN} , and Temperature



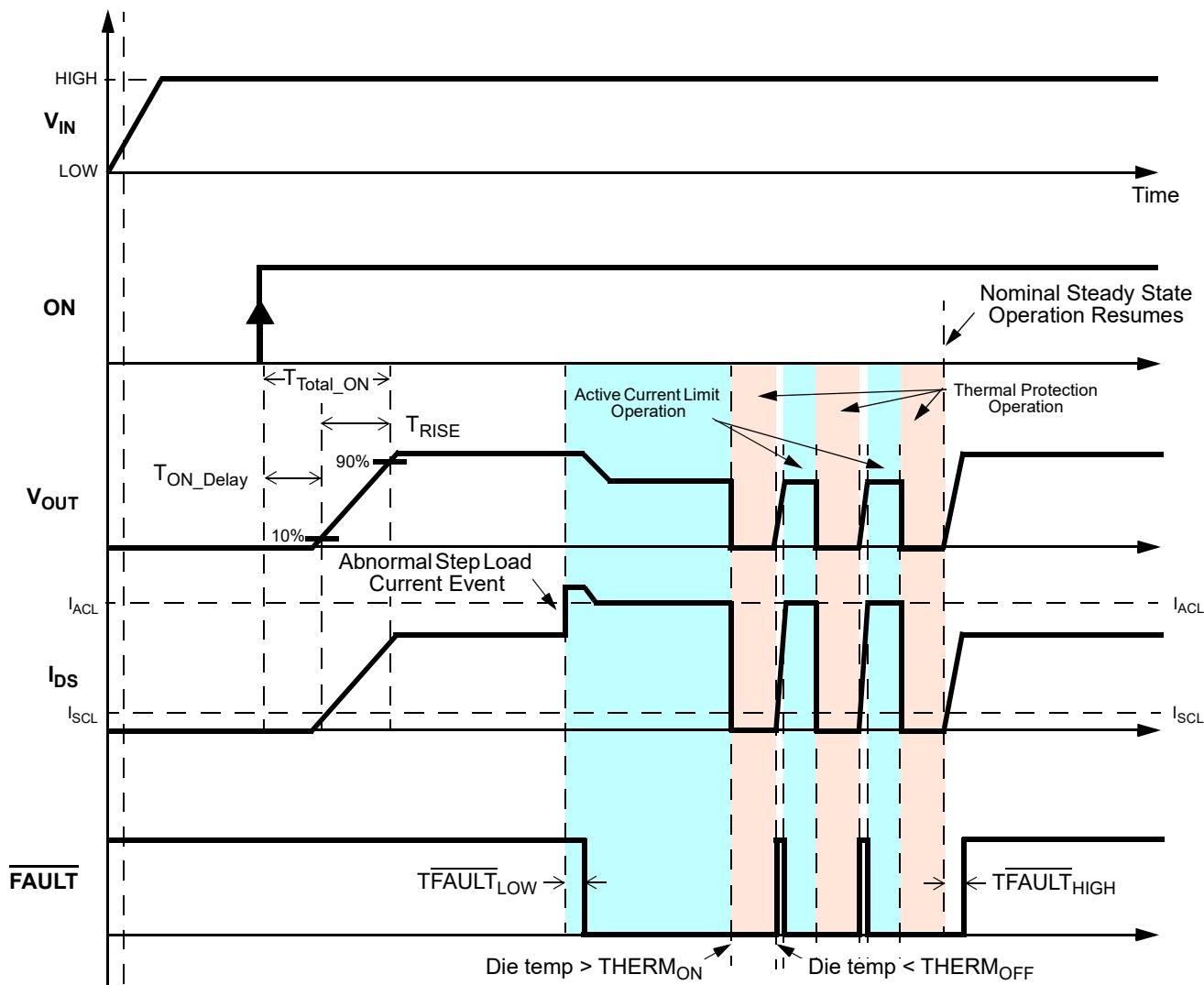
A 12 V, 18 mΩ, 5 A Load Switch
with V_{IN} Lockout Select and MOSFET Current Monitor Output

Timing Diagram - Basic Operation including Active Current Limit Protection



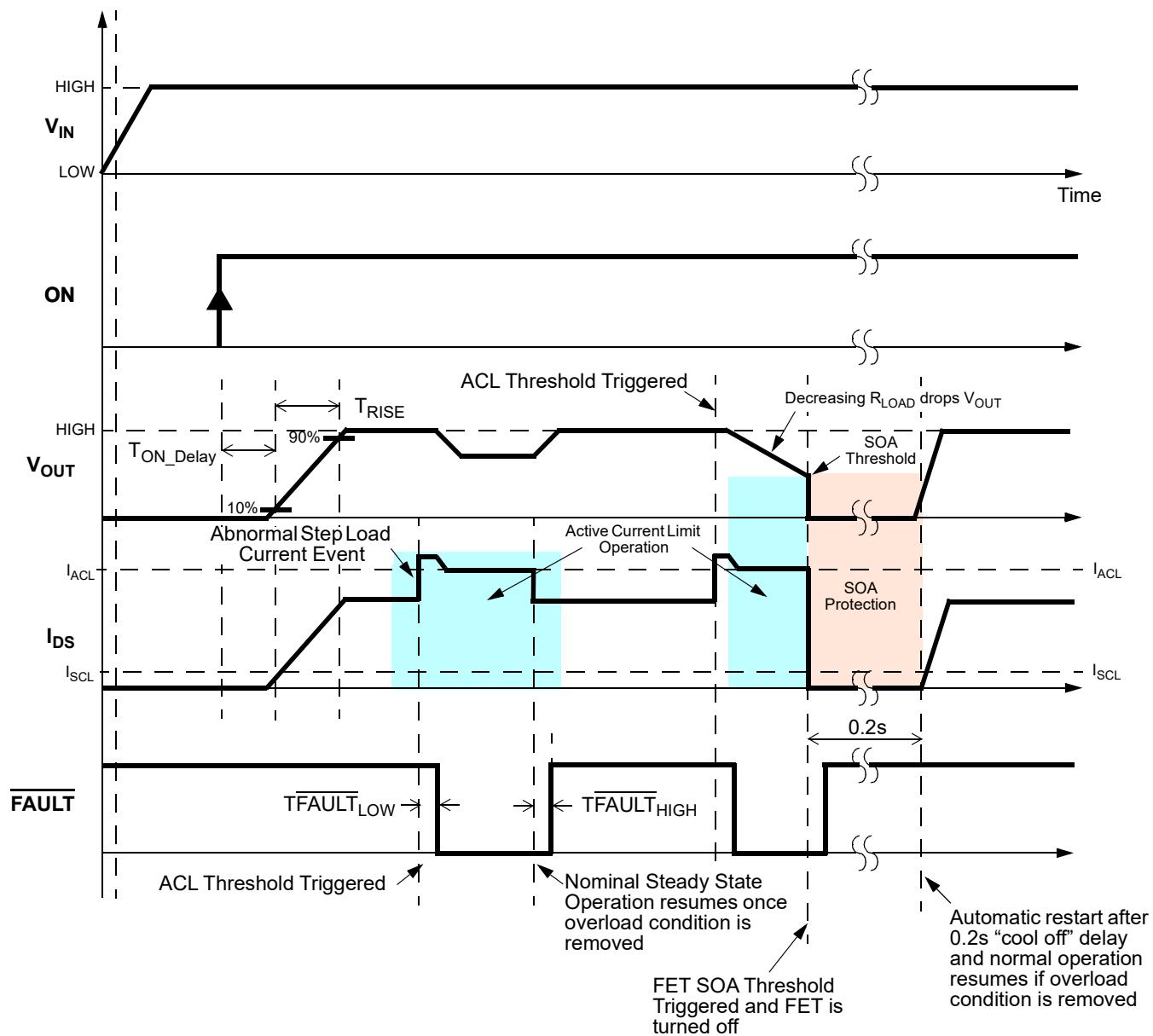
A 12 V, 18 mΩ, 5 A Load Switch
with V_{IN} Lockout Select and MOSFET Current Monitor Output

Timing Diagram - Active Current Limit & Thermal Protection Operation



A 12 V, 18 mΩ, 5 A Load Switch
with V_{IN} Lockout Select and MOSFET Current Monitor Output

Timing Diagram - Basic Operation including Active Current + Internal FET SOA Protection



SLG59H1120V

A 12 V, 18 mΩ, 5 A Load Switch
with V_{IN} Lockout Select and MOSFET Current Monitor Output

SLG59H1120V Application Diagram

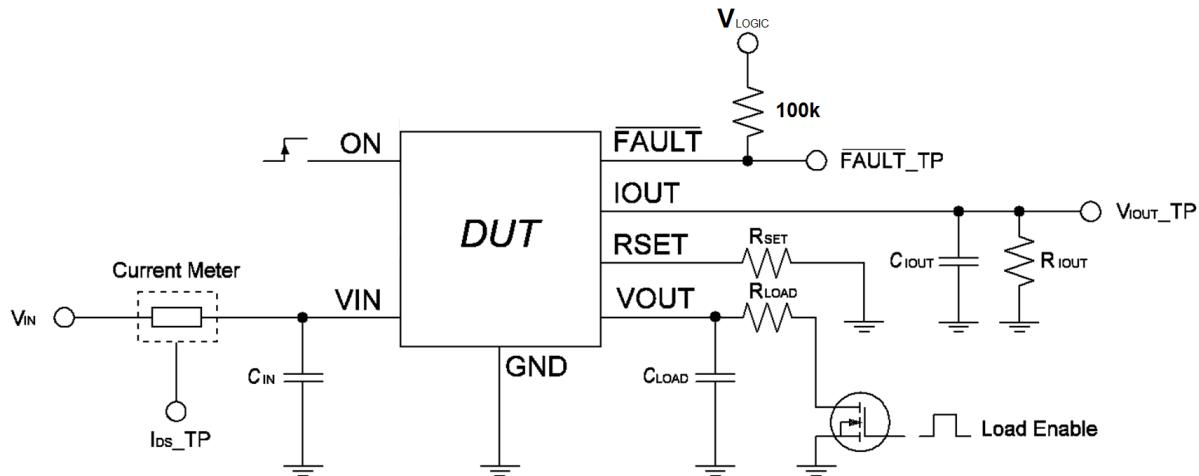
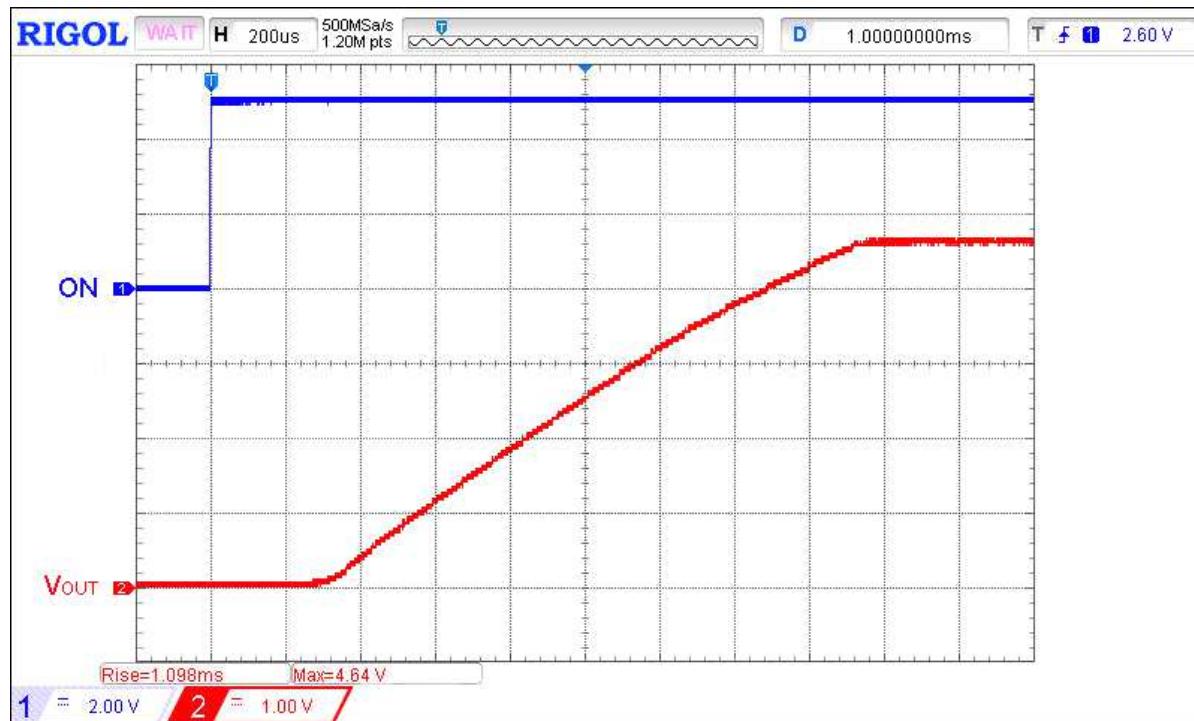


Figure 1. Test setup Application Diagram

Typical Turn-on Waveforms

Figure 2. Typical Turn ON operation waveform for $V_{IN} = 4.5$ V, $C_{SLEW} = 10$ nF, $C_{LOAD} = 10$ μF, $R_{LOAD} = 100$ Ω

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A 12 V, 18 mΩ, 5 A Load Switch
with V_{IN} Lockout Select and MOSFET Current Monitor Output

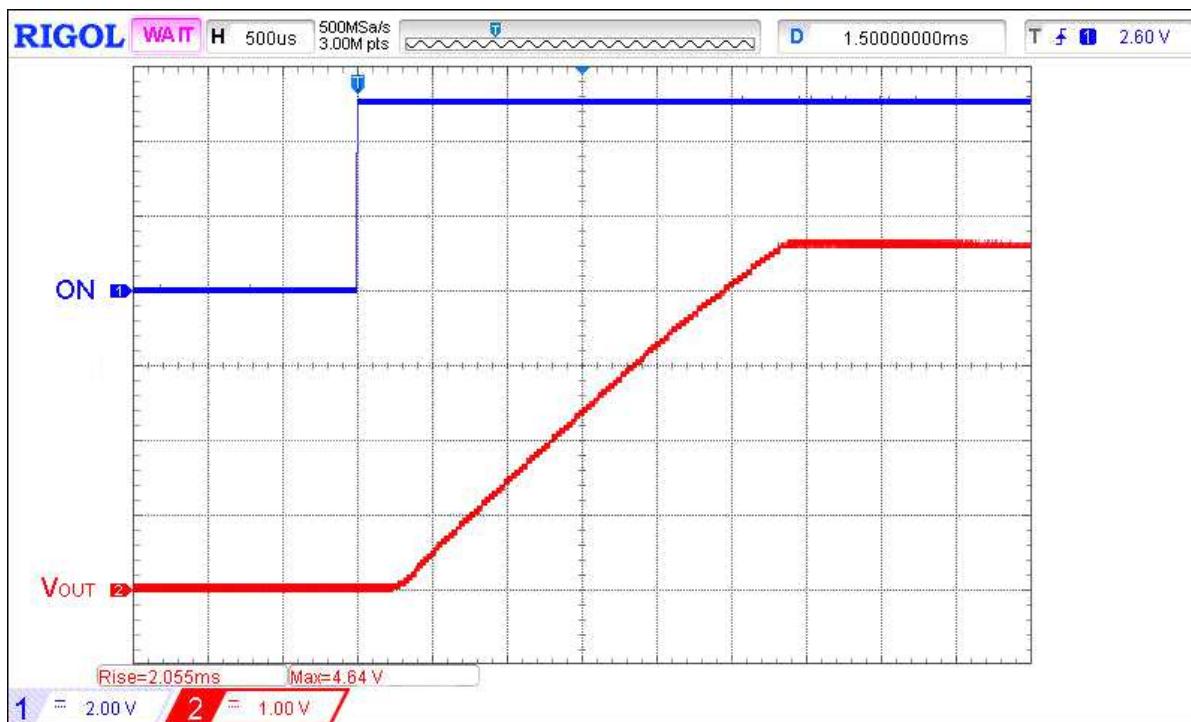


Figure 3. Typical Turn ON operation waveform for $V_{IN} = 4.5$ V, $C_{SLEW} = 18$ nF, $C_{LOAD} = 10$ μ F, $R_{LOAD} = 100$ Ω

Typical Turn-off Waveforms

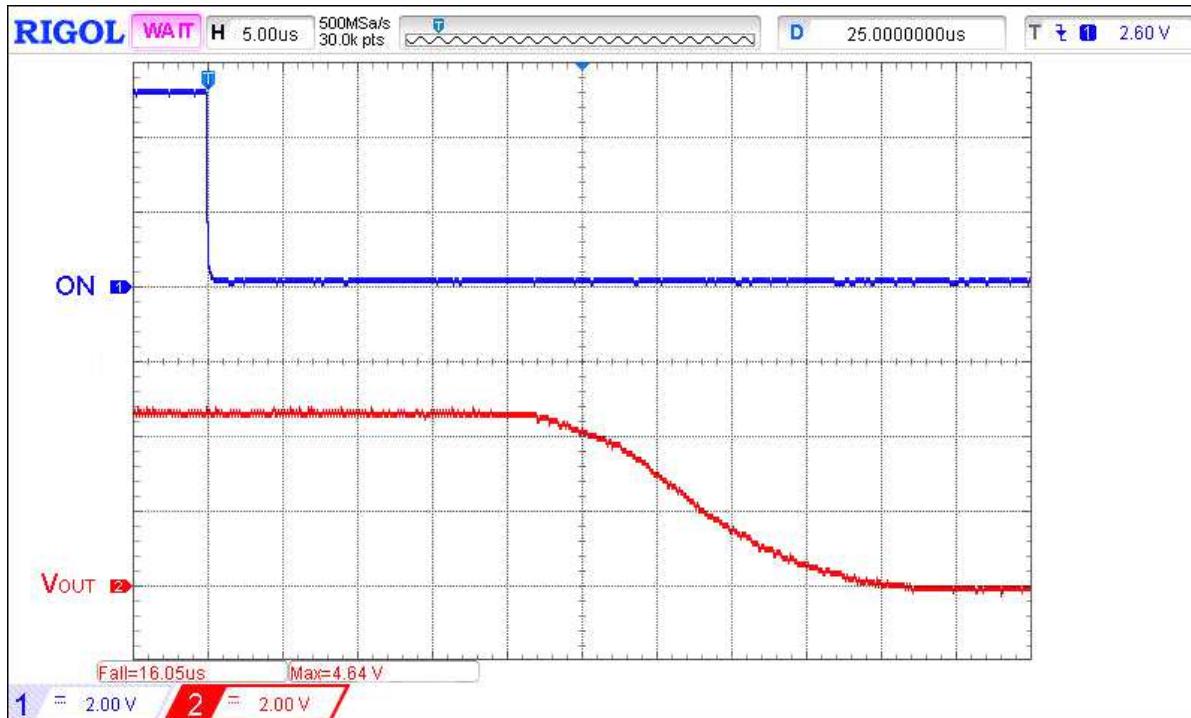


Figure 4. Typical Turn OFF operation waveform for $V_{IN} = 4.5$ V, $C_{SLEW} = 10$ nF, no C_{LOAD} , $R_{LOAD} = 100$ Ω

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A 12 V, 18 mΩ, 5 A Load Switch
with V_{IN} Lockout Select and MOSFET Current Monitor Output

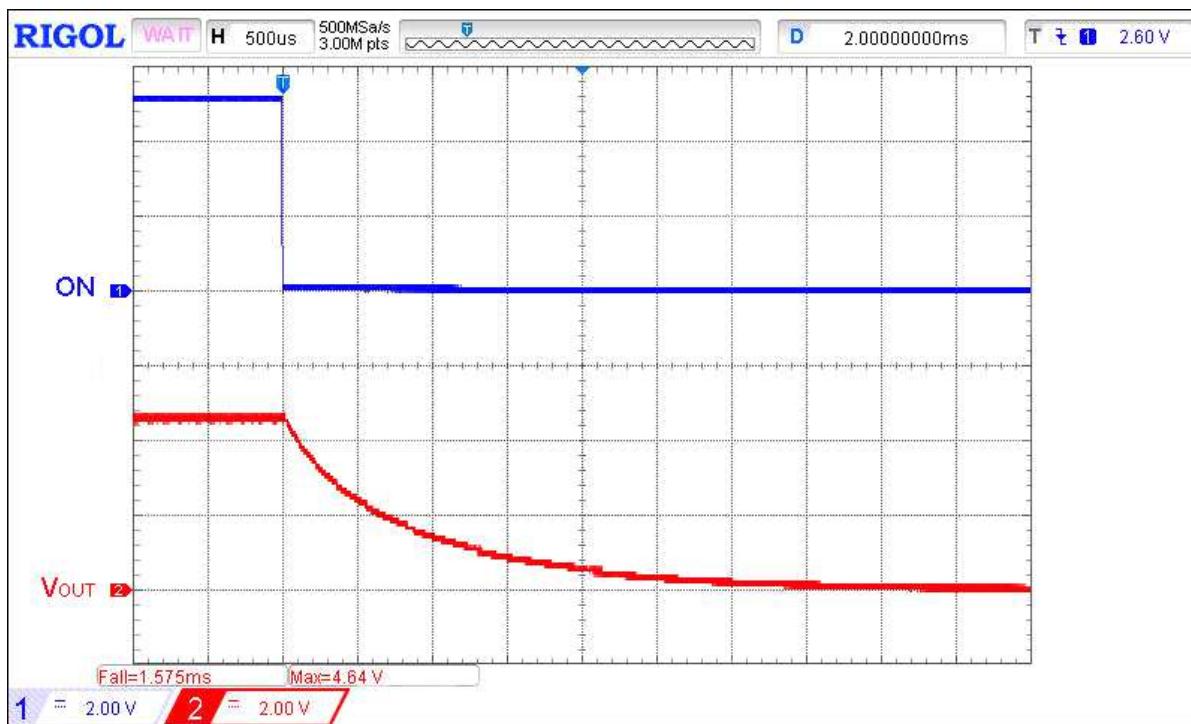


Figure 5. Typical Turn OFF operation waveform for $V_{IN} = 4.5$ V, $C_{SLEW} = 10$ nF, $C_{LOAD} = 10$ μ F, $R_{LOAD} = 100$ Ω

Typical ACL Operation Waveforms

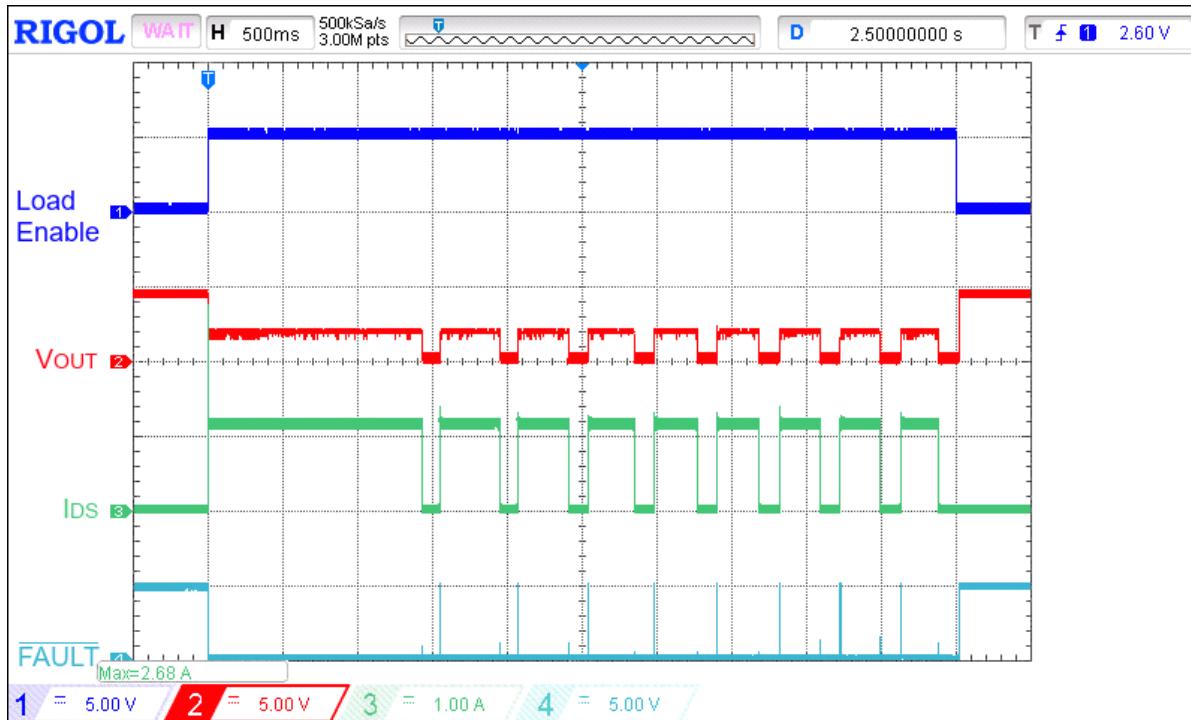


Figure 6. Typical ACL operation waveform for $V_{IN} = 4.5$ V, $C_{LOAD} = 10$ μ F, $I_{ACL} = 1$ A, $R_{SET} = 91$ $k\Omega$

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A 12 V, 18 mΩ, 5 A Load Switch
with V_{IN} Lockout Select and MOSFET Current Monitor Output

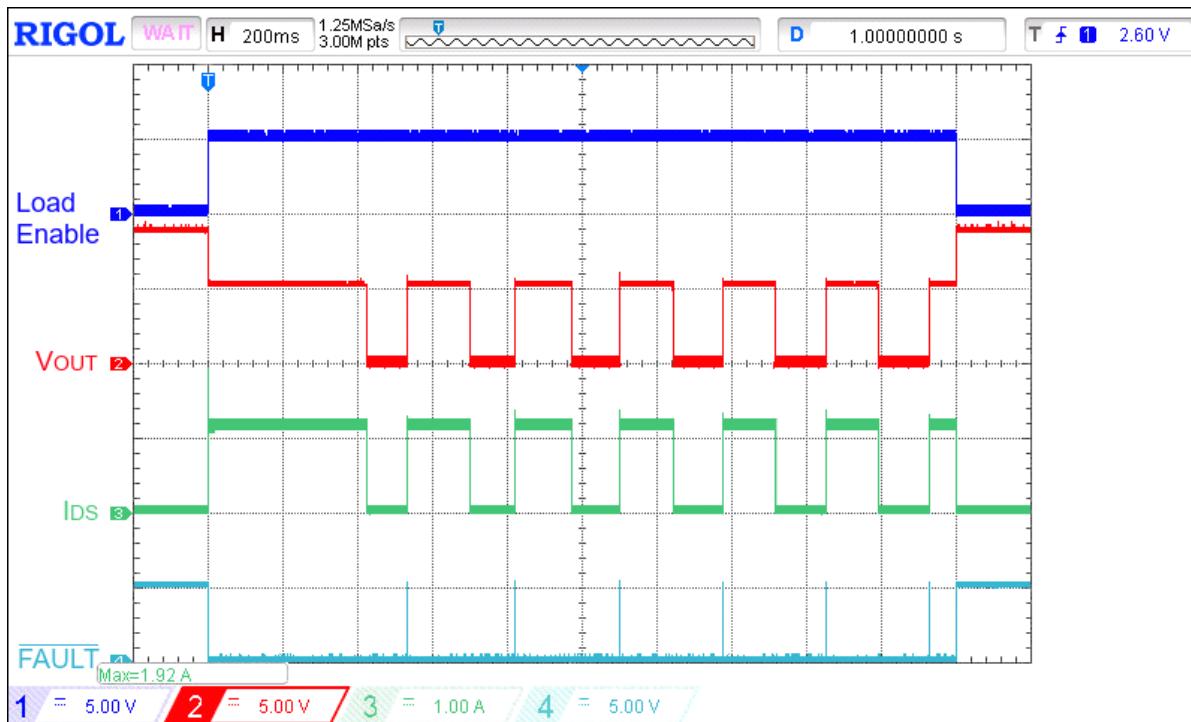


Figure 7. Typical ACL operation waveform for $V_{IN} = 9$ V, $C_{LOAD} = 10$ μ F, $I_{ACL} = 1$ A, $R_{SET} = 91$ k Ω

Typical FAULT Operation Waveforms

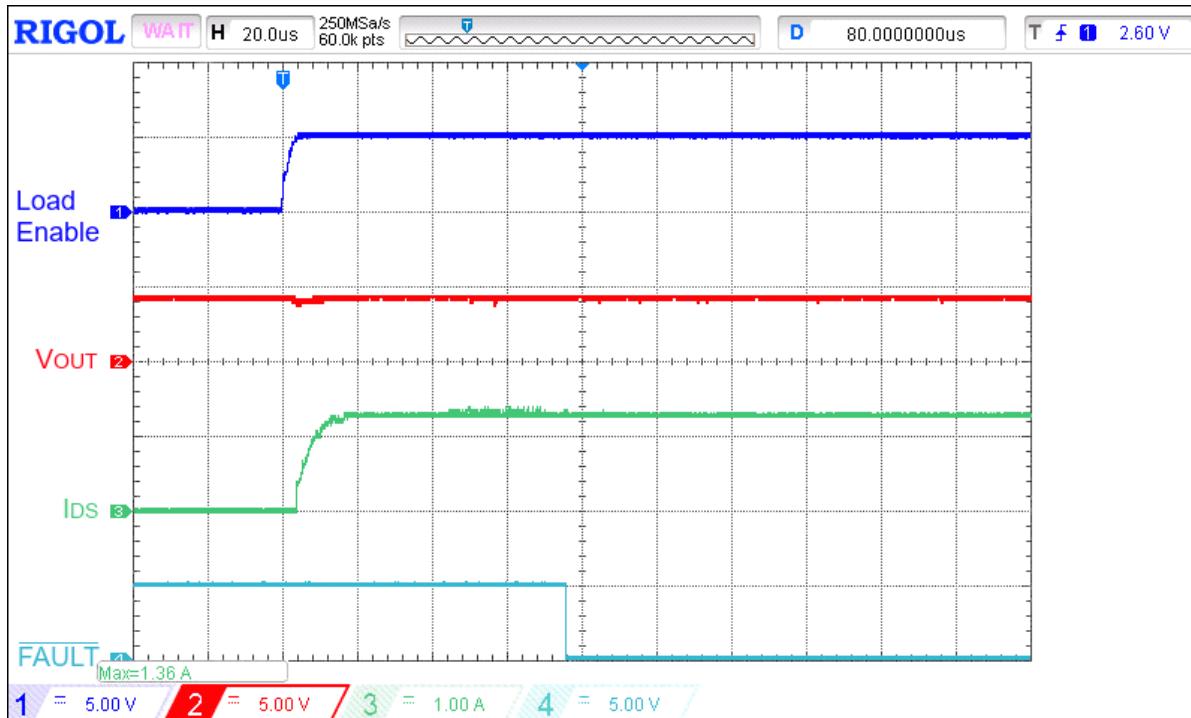


Figure 8. Typical FAULT assertion waveform for $V_{IN} = 4.5$ V, $C_{LOAD} = 10$ μ F, $I_{ACL} = 1$ A, $R_{SET} = 91$ k Ω , switch on 3.3 Ω load

SLG59H1120V

A 12 V, 18 mΩ, 5 A Load Switch
with V_{IN} Lockout Select and MOSFET Current Monitor Output

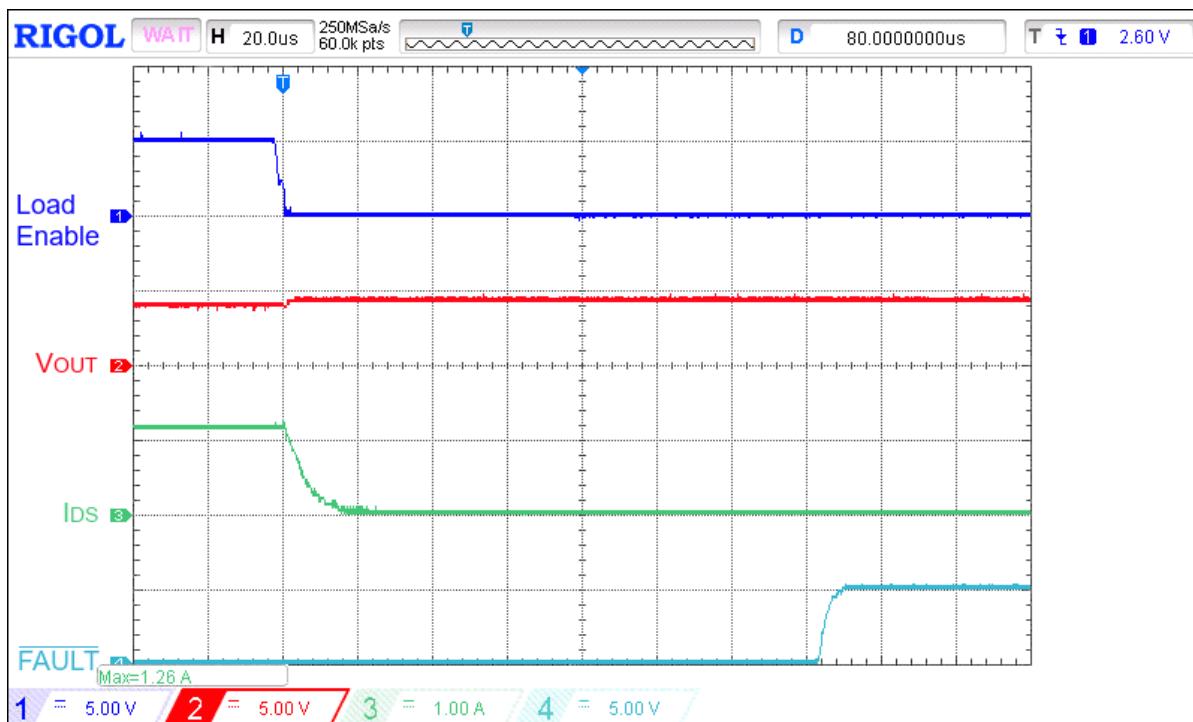


Figure 9. Typical FAULT de-assertion waveform for $V_{IN} = 4.5$ V, $C_{LOAD} = 10 \mu\text{F}$, $I_{ACL} = 1$ A, $R_{SET} = 91$ kΩ, switch out 3.3 Ω load

Applications Information

High Voltage GreenFET Safe Operating Area Explained

Renesas's High Voltage GreenFET load switches incorporate a number of internal protection features that prevents them from damaging themselves or any other circuit or subcircuit downstream of them. One particular protection feature is their Safe Operation Area (SOA) protection. SOA protection is automatically activated under overpower and, in some cases, under overcurrent conditions. Overpower SOA is activated if package power dissipation exceeds an internal 5 W threshold longer than 2.5 ms. High Voltage GreenFET devices will quickly switch off (open circuit) upon overpower detection and automatically resume (close) nominal operation once overpower condition no longer exists.

One possible way to have an overpower condition trigger SOA protection is when High Voltage GreenFET products are enabled into heavy output resistive loads and/or into large load capacitors. It is under these conditions to follow carefully the "Safe Start-up Loading" guidance in the Applications section of the datasheet. During an overcurrent condition, High Voltage GreenFET devices will try to limit the output current to the level set by the external R_{SET} resistor. Limiting the output current, however, causes an increased voltage drop across the FET's channel because the FET's RDS_{ON} increased as well. Since the FET's RDS_{ON} is larger, package power dissipation also increases. If the resultant increase in package power dissipation is higher/equal than 5 W for longer than 2.5 ms, internal SOA protection will be triggered and the FET will open circuit (switch off). Every time SOA protection is triggered, all High Voltage GreenFET devices will automatically attempt to resume nominal operation after 160 ms.

Safe Start-up Condition

SLG59H1120V has built-in protection to prevent over-heating during start-up into a heavy load. Overloading the V_{OUT} pin with a capacitor and a resistor may result in non-monotonic V_{OUT} ramping. In general, under light loading on V_{OUT}, V_{OUT} ramping can be controlled with C_{SLEW} value. The following equation serves as a guide:

$$C_{SLEW} = \frac{T_{RISE}}{V_{IN}} \times 4.9 \mu\text{A} \times \frac{20}{3}$$

where

T_{RISE} = Total rise time from 10% V_{OUT} to 90% V_{OUT}

V_{IN} = Input Voltage

C_{SLEW} = Capacitor value for CAP pin

When capacitor and resistor loading on V_{OUT} during start up, the following tables will ensure V_{OUT} ramping is monotonic without triggering internal protection:

| Safe Start-up Loading for V _{IN} = 12 V (Monotonic Ramp) | | | |
|---|-------------------------------------|------------------------|-----------------------|
| Slew Rate (V/ms) | C _{SLEW} (nF) ² | C _{LOAD} (μF) | R _{LOAD} (Ω) |
| 1 | 33.3 | 500 | 20 |
| 2 | 16.7 | 250 | 20 |
| 3 | 11.1 | 160 | 20 |
| 4 | 8.3 | 120 | 20 |
| 5 | 6.7 | 100 | 20 |

Note 2: Select the closest-value tolerance capacitor.

SLG59H1120V

A 12 V, 18 mΩ, 5 A Load Switch
with V_{IN} Lockout Select and MOSFET Current Monitor Output

Setting the SLG59H1120V's Active Current Limit

| R_{SET} (kΩ) | Active Current Limit (A) ³ |
|----------------|---------------------------------------|
| 91 | 1 |
| 45 | 2 |
| 30 | 3 |
| 18 | 5 |

Note 3: Active Current Limit accuracy is ±15% over voltage range and over temperature range.

Setting the SLG59H1120V's Input Overvoltage Lockout Threshold

As shown in the table below, SEL[1,0] selects the V_{IN} overvoltage threshold at which the SLG59H1120V's internal state machine will turn OFF (open circuit) the power MOSFET if V_{IN} exceeds the selected threshold.

| SEL1 | SEL0 | $V_{IN(OVLO)}$ (Typ) |
|------|------|----------------------|
| 0 | 0 | 6 V |
| 0 | 1 | 10.8 V |
| 1 | 0 | 14.4 V |
| 1 | 1 | Reserved |

With an activated SLG59H1120V (ON=HIGH) and at any time V_{IN} crosses the programmed V_{IN} overvoltage threshold, the state machine opens the load switch and asserts the FAULT pin within T_{FAULT_LOW} .

In applications with a deactivated or inactive SLG59H1120V ($V_{IN} > V_{IN(OVLO)}$ and ON=LOW) and if the applied V_{IN} is higher than the programmed $V_{IN(OVLO)}$ threshold, the SLG59H1120V's state machine will keep the load switch open circuited if the ON pin is toggled LOW-to-HIGH. In these cases, the FAULT pin will also be asserted within T_{FAULT_LOW} and will remain asserted until V_{IN} resumes nominal, steady-state operation.

In all cases, the SLG59H1120V's V_{IN} undervoltage lockout threshold is fixed at $V_{IN(UVLO)}$.

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A 12 V, 18 mΩ, 5 A Load Switch
with V_{IN} Lockout Select and MOSFET Current Monitor Output

Power Dissipation

The junction temperature of the SLG59H1120V depends on different factors such as board layout, ambient temperature, and other environmental factors. The primary contributor to the increase in the junction temperature of the SLG59H1120V is the power dissipation of its power MOSFET. Its power dissipation and the junction temperature in nominal operating mode can be calculated using the following equations:

$$PD = RDS_{ON} \times I_{DS}^2$$

where:

PD = Power dissipation, in Watts (W)

R_{DS}_{ON} = Power MOSFET ON resistance, in Ohms (Ω)

I_{DS} = Output current, in Amps (A)

and

$$T_J = PD \times \theta_{JA} + T_A$$

where:

T_J = Junction temperature, in Celsius degrees (°C)

θ_{JA} = Package thermal resistance, in Celsius degrees per Watt (°C/W)

T_A = Ambient temperature, in Celsius degrees (°C)

In current-limit mode, the SLG59H1120V's power dissipation can be calculated by taking into account the voltage drop across the load switch (V_{IN}-V_{OUT}) and the magnitude of the output current in current-limit mode (I_{ACL}):

$$PD = (V_{IN} - V_{OUT}) \times I_{ACL} \text{ or}$$

$$PD = (V_{IN} - (R_{LOAD} \times I_{ACL})) \times I_{ACL}$$

where:

PD = Power dissipation, in Watts (W)

V_{IN} = Input Voltage, in Volts (V)

R_{LOAD} = Load Resistance, in Ohms (Ω)

I_{ACL} = Output limited current, in Amps (A)

V_{OUT} = R_{LOAD} × I_{ACL}

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Layout Guidelines:

1. Since the VIN and VOUT pins dissipate most of the heat generated during high-load current operation, it is highly recommended to make power traces as short, direct, and wide as possible. A good practice is to make power traces with an absolute minimum widths of 15 mils (0.381 mm) per Ampere. A representative layout, shown in [Figure 10](#), illustrates proper techniques for heat to transfer as efficiently as possible out of the device;
2. To minimize the effects of parasitic trace inductance on normal operation, it is recommended to connect input C_{IN} and output C_{LOAD} low-ESR capacitors as close as possible to the SLG59H1120V's VIN and VOUT pins;
3. The GND pin should be connected to system analog or power ground plane.
4. 2 oz. copper is recommended for high current operation.

SLG59H1120V Evaluation Board:

A High Voltage GreenFET Evaluation Board for SLG59H1120V is designed according to the statements above and is illustrated on [Figure 10](#). Please note that evaluation board has D_Sense and S_Sense pads. They cannot carry high currents and dedicated only for RDS_{ON} evaluation.

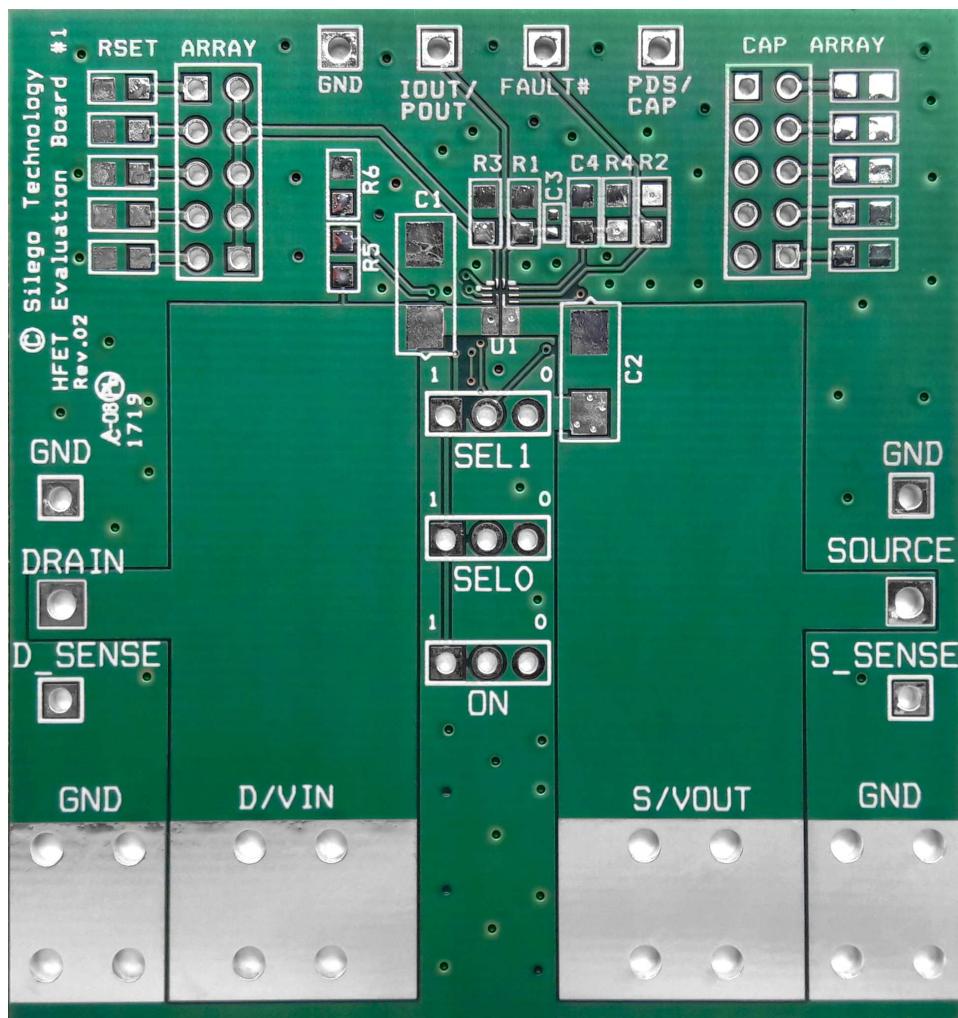


Figure 10. SLG59H1120V Evaluation Board

SLG59H1120V

A 12 V, 18 mΩ, 5 A Load Switch
with V_{IN} Lockout Select and MOSFET Current Monitor Output

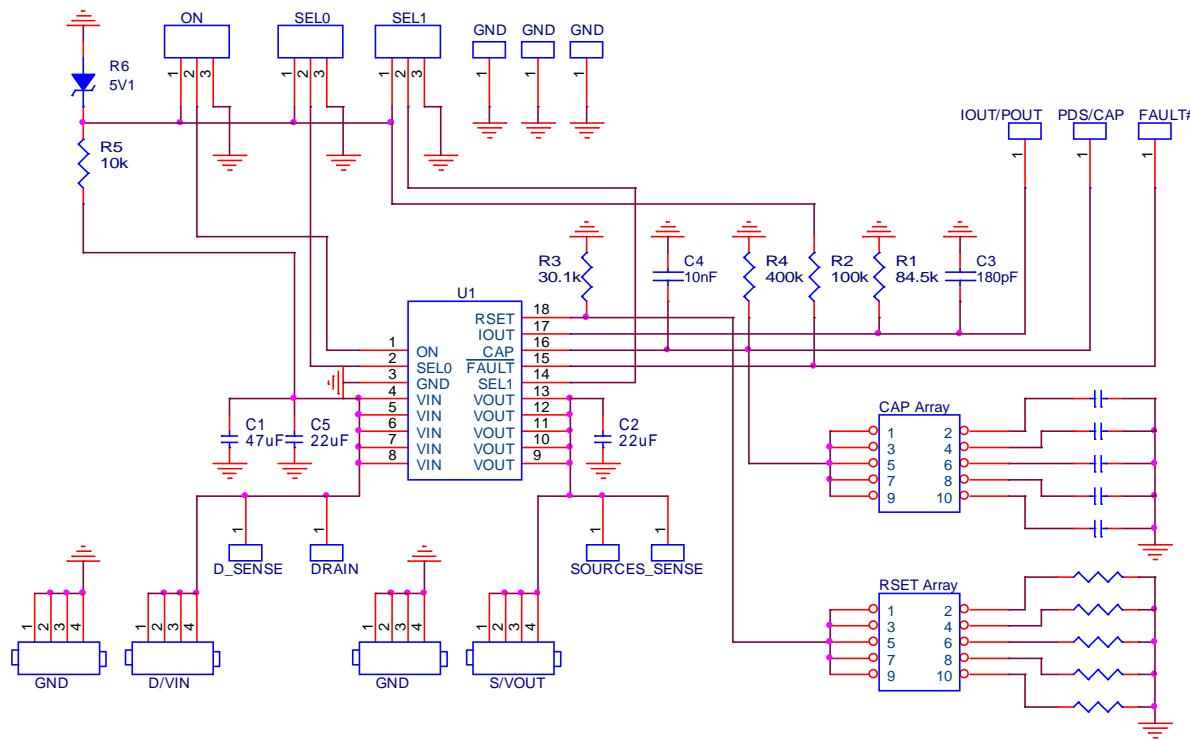


Figure 11. SLG59H1120V Evaluation Board Connection Circuit

Basic Test Setup and Connections

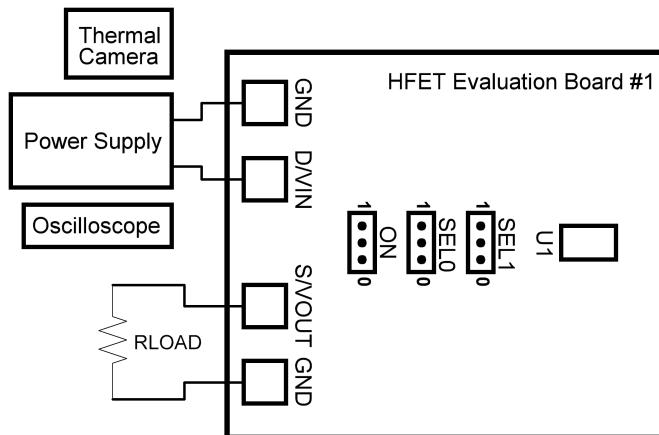


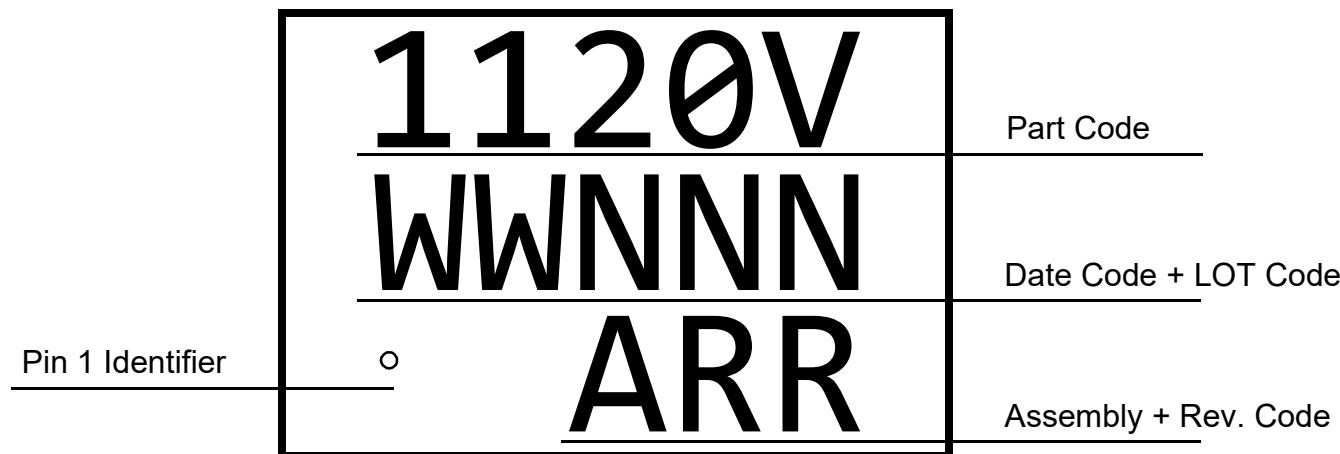
Figure 12. SLG59H1120V Evaluation Board Connection Circuit

EVB Configuration

1. Based on V_{IN} voltage, set SEL0, SEL1 to GND or 5 V to configure OVLO;
2. Connect oscilloscope probes to D/VIN, S/VOUT, ON, etc.;
3. Turn on Power Supply and set desired V_{IN} from 4.5 V...12 V range;
4. Toggle the ON signal High or Low to observe SLG59H1120V operation.

A 12 V, 18 mΩ, 5 A Load Switch
with V_{IN} Lockout Select and MOSFET Current Monitor Output

Package Top Marking System Definition



1120V - Part ID Field

WW - Date Code Field¹

NNN - Lot Traceability Code Field¹

A - Assembly Site Code Field²

RR - Part Revision Code Field²

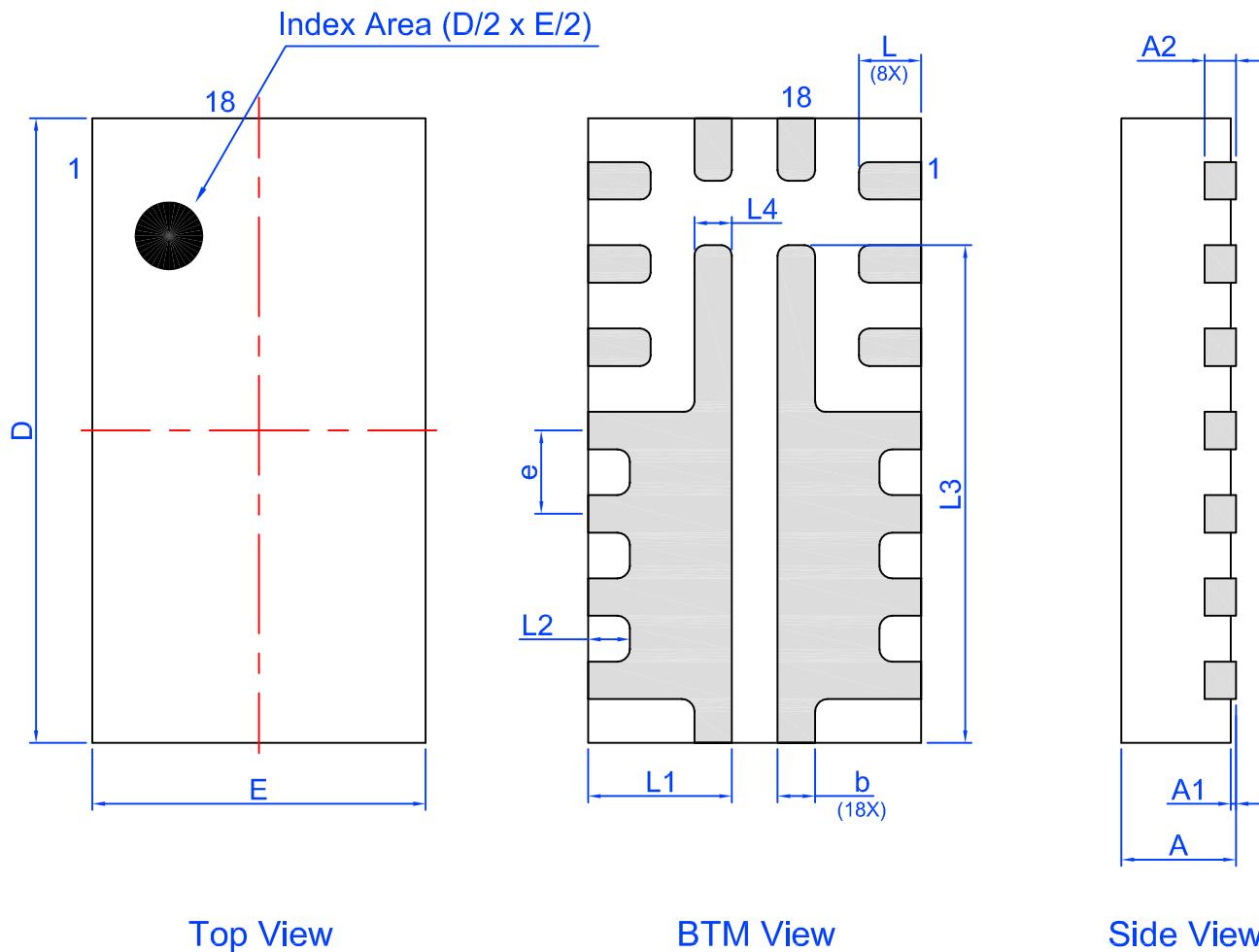
Note 1: Each character in code field can be alphanumeric A-Z and 0-9

Note 2: Character in code field can be alphabetic A-Z

A 12 V, 18 mΩ, 5 A Load Switch
with V_{IN} Lockout Select and MOSFET Current Monitor Output

Package Drawing and Dimensions

18 Lead TQFN Package 1.6 x 3 mm (Fused Lead)
JEDEC MO-220, Variation WCEE



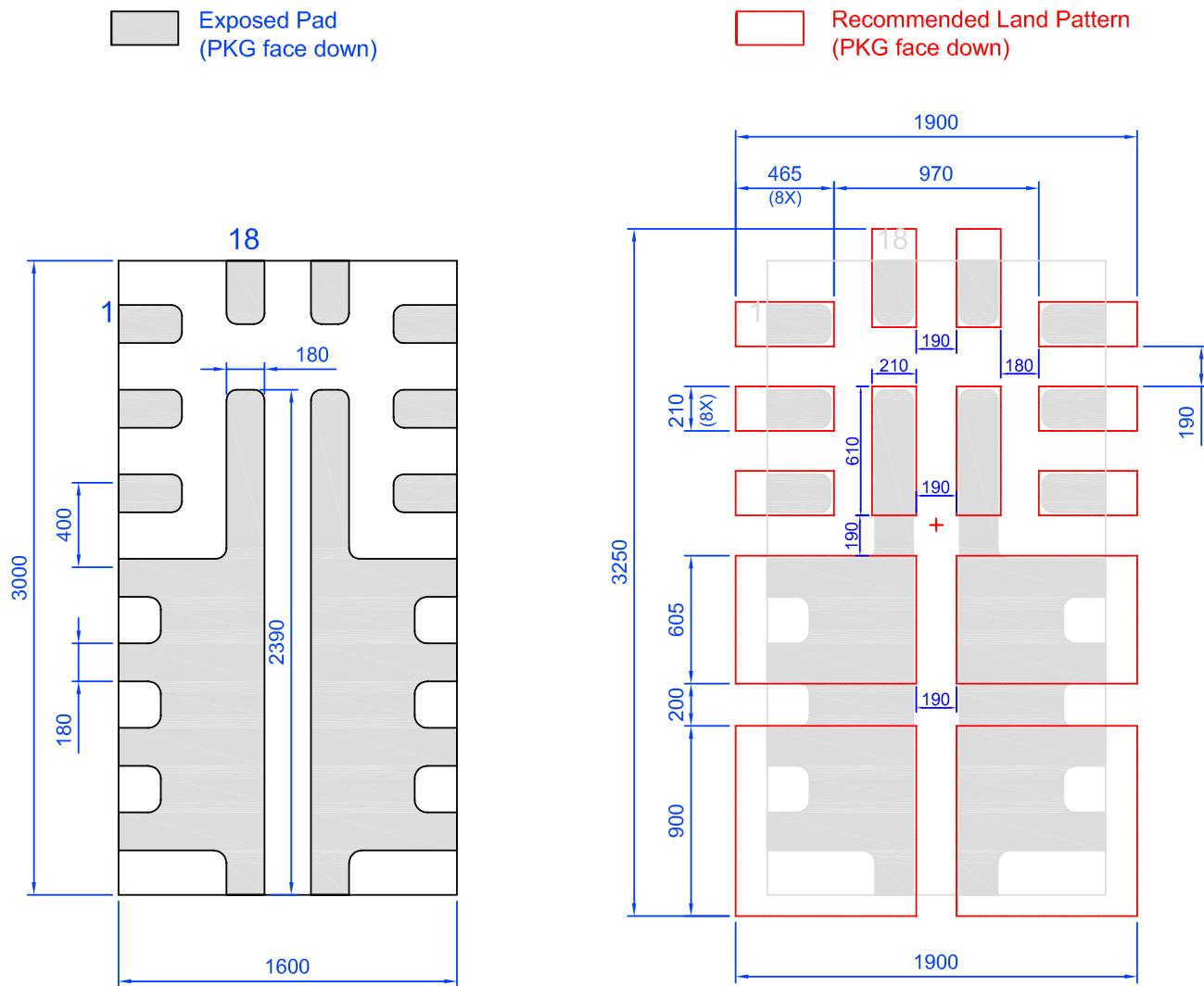
Unit: mm

| Symbol | Min | Nom. | Max | Symbol | Min | Nom. | Max |
|--------|----------|------|------|--------|------|------|------|
| A | 0.50 | 0.55 | 0.60 | D | 2.95 | 3.00 | 3.05 |
| A1 | 0.005 | - | 0.05 | E | 1.55 | 1.60 | 1.65 |
| A2 | 0.10 | 0.15 | 0.20 | L | 0.25 | 0.30 | 0.35 |
| b | 0.13 | 0.18 | 0.23 | L1 | 0.64 | 0.69 | 0.74 |
| e | 0.40 BSC | | | L2 | 0.15 | 0.20 | 0.25 |
| L3 | 2.34 | 2.39 | 2.44 | L4 | 0.13 | 0.18 | 0.23 |

SLG59H1120V

A 12 V, 18 mΩ, 5 A Load Switch
with V_{IN} Lockout Select and MOSFET Current Monitor Output

SLG59H1120V 18-pin STQFN PCB Landing Pattern



Note: All dimensions shown in micrometers (µm)

SLG59H1120V

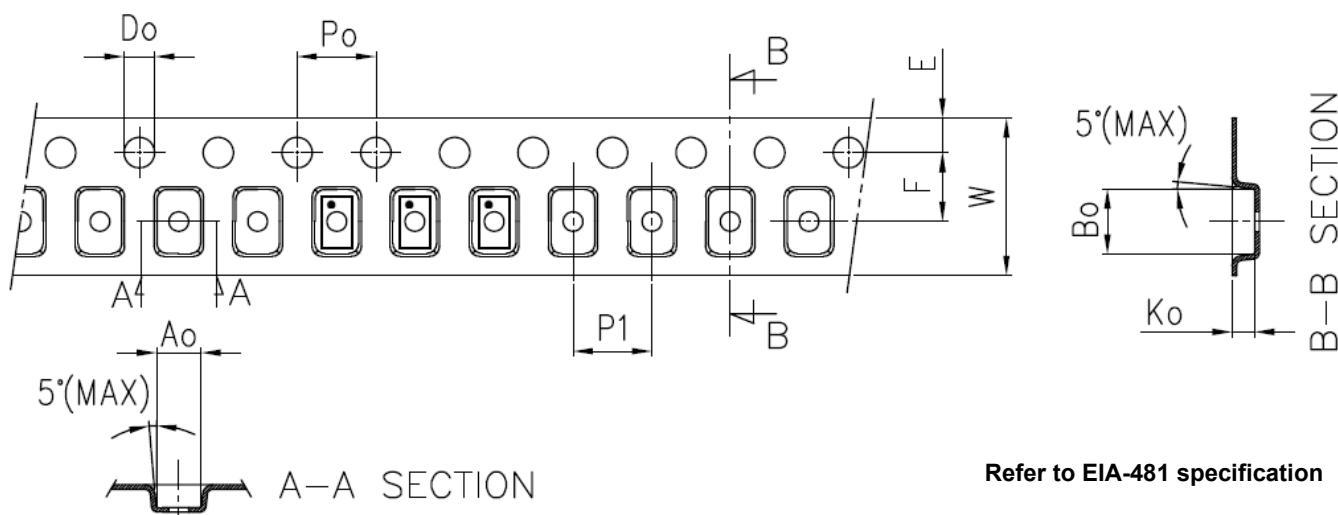
A 12 V, 18 mΩ, 5 A Load Switch
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Tape and Reel Specifications

| Package Type | # of Pins | Nominal Package Size [mm] | Max Units | | Reel & Hub Size [mm] | Leader (min) | | Trailer (min) | | Tape Width [mm] | Part Pitch [mm] |
|--|-----------|---------------------------|-----------|---------|----------------------|--------------|-------------|---------------|-------------|-----------------|-----------------|
| | | | per Reel | per Box | | Pockets | Length [mm] | Pockets | Length [mm] | | |
| STQFN 18L 1.6x3mm 0.4P FC Green | 18 | 1.6 x 3 x 0.55 | 3,000 | 3,000 | 178 / 60 | 100 | 400 | 100 | 400 | 8 | 4 |

Carrier Tape Drawing and Dimensions

| Package Type | Pocket BTM Length | Pocket BTM Width | Pocket Depth | Index Hole Pitch | Pocket Pitch | Index Hole Diameter | Index Hole to Tape Edge | Index Hole to Pocket Center | Tape Width |
|--|-------------------|------------------|--------------|------------------|--------------|---------------------|-------------------------|-----------------------------|------------|
| | A0 | B0 | K0 | P0 | P1 | D0 | E | F | W |
| STQFN 18L 1.6x3mm 0.4P FC Green | 1.78 | 3.18 | 0.76 | 4 | 4 | 1.5 | 1.75 | 3.5 | 8 |



Recommended Reflow Soldering Profile

Please see IPC/JEDEC J-STD-020: latest revision for reflow profile based on package volume of 2.64 mm³ (nominal). More information can be found at www.jedec.org.

SLG59H1120V

A 12 V, 18 mΩ, 5 A Load Switch
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Revision History

| Date | Version | Change |
|------------|---------|--|
| 2/2/2022 | 1.03 | Updated Company name and logo Added SOA Protection Threshold to Features Fixed typos |
| 12/12/2018 | 1.02 | Updated style and formatting Updated Charts Updated Scopeshots Added Layout Guidelines Fixed typos |
| 10/03/2016 | 1.01 | Fixed Chart on Page 6 |
| 8/25/2016 | 1.00 | Production Release |

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